

Presentation at University of Virginia

**Mechanical Behavior of a Polycrystalline C-2000
and an Amorphous $\text{Zr}_{50}\text{Cu}_{40}\text{Al}_{10}$ Alloy Subjected
to Surface Severe Plastic Deformation (S^2PD)**

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- Collaborators: Dr. L.L. Shaw, Dr. A. Ortiz, Dr. Y. Yokoyama, Dr. D. Klarstrom, Dr. P.J. Withers, and Dr. A.L. Greer

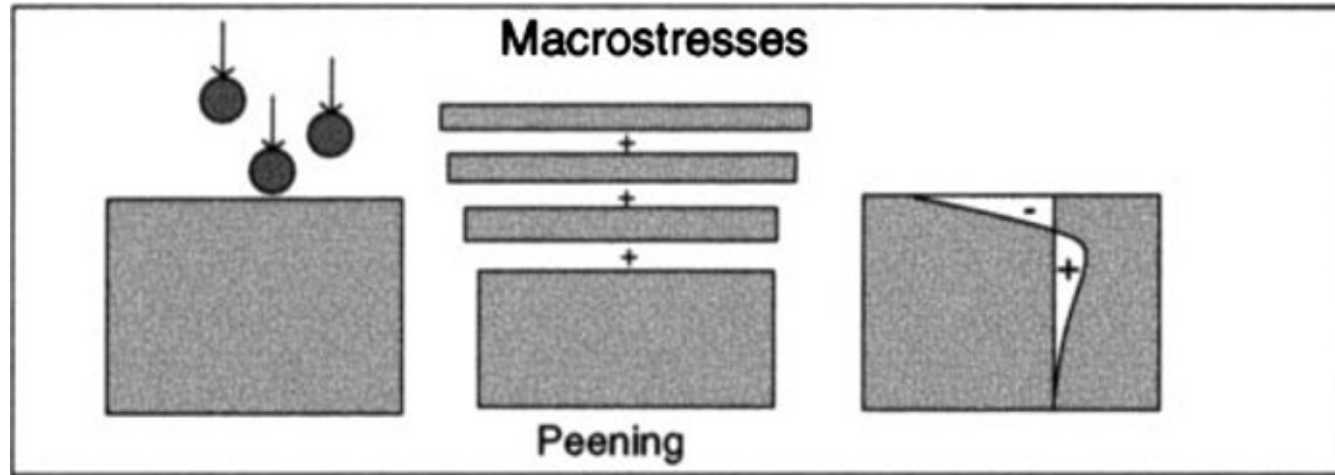
Outline

- Background Reviews
- Experimental Procedures
- Effects of Surface Treatments on Polycrystalline Ni-based C-2000 Superalloy
- Effects of Surface Treatments on Amorphous Zr-based $\text{Zr}_{50}\text{Cu}_{40}\text{Al}_{10}$ Bulk Metallic Glass
- Summary

Shot peening: an old process

- Shot peening is a process used to produce a compressive residual stress layer and modify mechanical properties;
- It entails impacting on a surface with shots (round metallic, glass, or ceramic particles) with force sufficient to create plastic deformation;
- Shot peening is often called for in aircraft repairs to relieve tensile stresses built up in the grinding process and replace them with beneficial compressive stresses;
- Shot peening can increase fatigue life from 0% – 1,000%, depending on the materials and peening parameters.

Effects of shot peening



- Residual stresses originate from misfits between different regions within a component – Type-I residual stress*
- Work hardening originates from the saturated dislocation density which has resistance to new dislocation-formation
- Surface roughness is a co-effect of dents-generating and peak-removing
- The above-mentioned features are closely related to fatigue property

Nanocrystallization: a hot topic

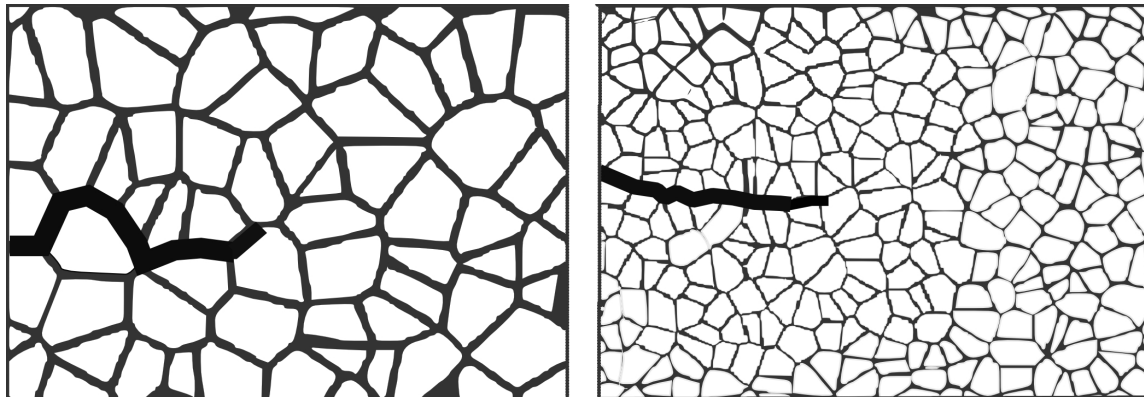
- Good global mechanical properties, such as high yield strengths and toughness, high hardness, good thermal and magnetic properties
- Generally, the nanocrystalline synthesis methods can be classified into two categories:
 - Breaking the large grain size down (a top-down method, such as equal channel angular pressing (ECAP))
 - Consolidating small clusters up (a bottom-up method, such as gas condensation, mechanical alloying, etc.)
- Difficulties:
 - High pressure required
 - Porosity/contamination problems

Effects of fine grains

- For crack initiation along a slip band, the number of cycles for a crack to initial, N_f , is proportional to the reciprocal of the grain size *, d , i.e.,

$$N_f \propto \frac{1}{d}$$

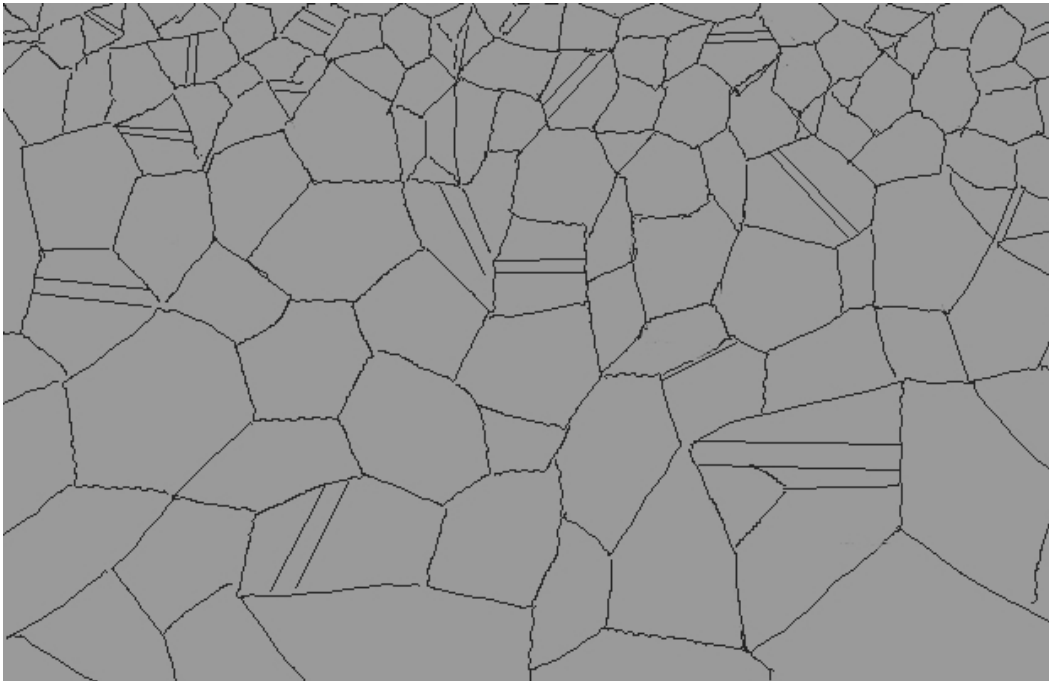
- Crack-growth path can be deflected by the coarse grain more effectively than by fine grains:



- It is usually true that cracks initiate from the surface and propagate into the interior in a fatigue test

* K.S. Chan, *Metallurgical and Materials Transactions A*, 34(2003), 43-58

Surface severe plastic deformation (S^2PD)



Schematic illustration of grain size profile after the S^2PD process

- Work-hardened surface layer ($\sim 1000 \mu m$)
- Surface region with compressive residual stresses
- Nanocrystalline (nc) surface layer ($5 \sim 100 \mu m$)
- Grain-size gradient with a nc surface and a coarse-grained interior

shot peening + surface nano-layer $\rightarrow S^2PD$

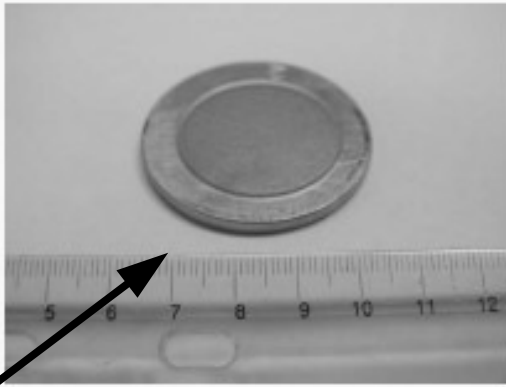
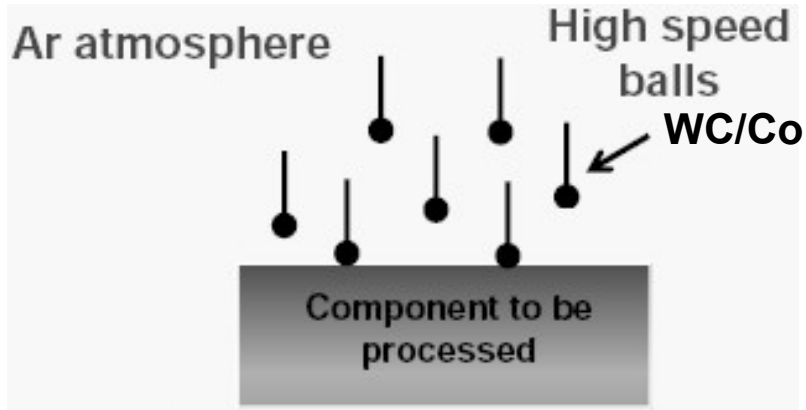
Why surface treatment?

- (Many) failures starting from the component surface
- Applying on existing components
- No heterogeneous composition/interface
- Taking advantage of the advanced properties of nanomaterials in a simple way
- Introducing beneficial compressive-residual stresses
- Improving the overall mechanical properties including fatigue property
- Any structural/property changes for bulk metallic glass system?

Experiments: materials

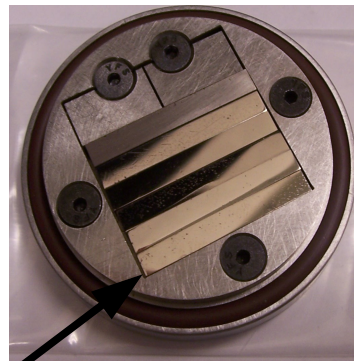
- Polycrystalline Ni-based C-2000 superalloy
 - Composition: 59Ni – 23Cr – 16Mo – 1.6Cu – 0.01max C – 0.08max Si, wt.%)
 - Structure: Single phase
Face Centered Cubic (fcc)
 - Main Properties:
Yield strength = 350 ~ 400 MPa
Elongation = 60 ~ 70 %
Density = 8.5 g/cm³
 - Geometry: Diameter = 50 mm
Thickness = 3.2 mm
- Zr-based bulk metallic glass
 - Zr₅₀Cu₄₀Al₁₀ (in at.%)
 - Properties:
T_g = 706 K; T_x = 792 K
T_i = 1,092 K
Yield strength = 1.86 GPa
Hardness = HV506
Modulus = 88 GPa
Elongation = 2.1%
 - Geometry: 3 × 3 × 25 mm³ bar
(original as-cast: Ø8.0 × 60 mm²)

Experiments: equipment



For C-2000 treatment

Sample: C-2000/Zr-based BMG
 Geometry: Diameter = 50 mm
 Balls: $\varnothing 7.9 \text{ mm} \times 5 \text{ units}$
 $\varnothing 4.9 \text{ mm} \times 5 \text{ units}$
 $\varnothing 1.6 \text{ mm} \times 20 \text{ units}$



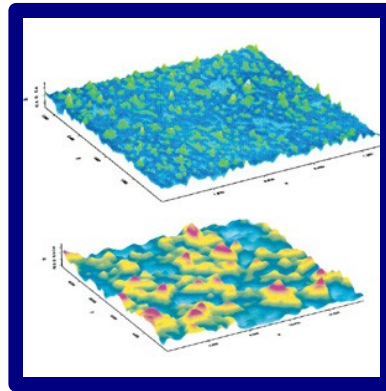
For BMG treatment



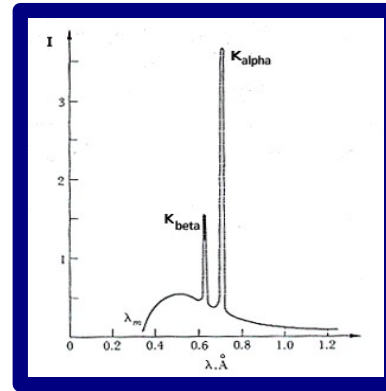
Experiments: tests performed



OM/SEM/TEM



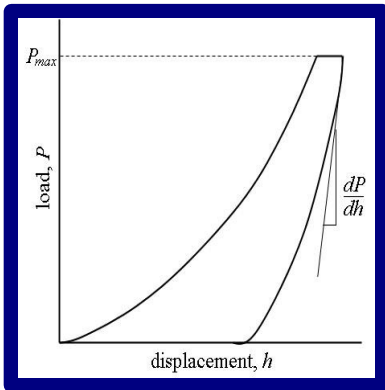
Roughness



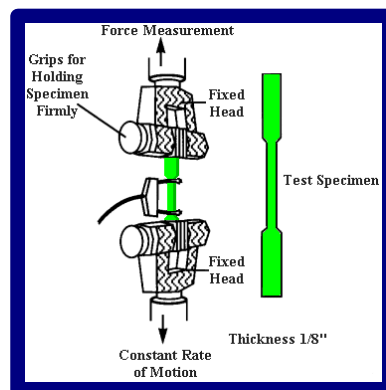
XRD/Synchrotron



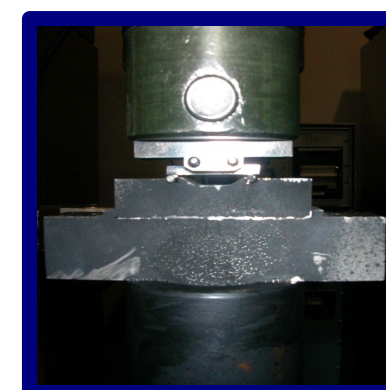
DSC



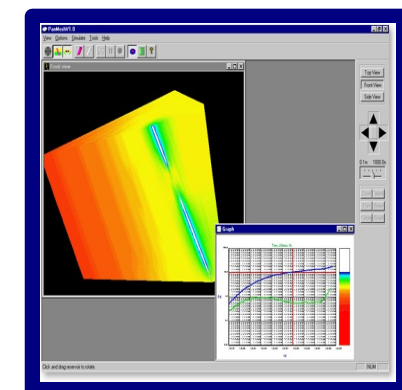
Nanoindentation



Tensile



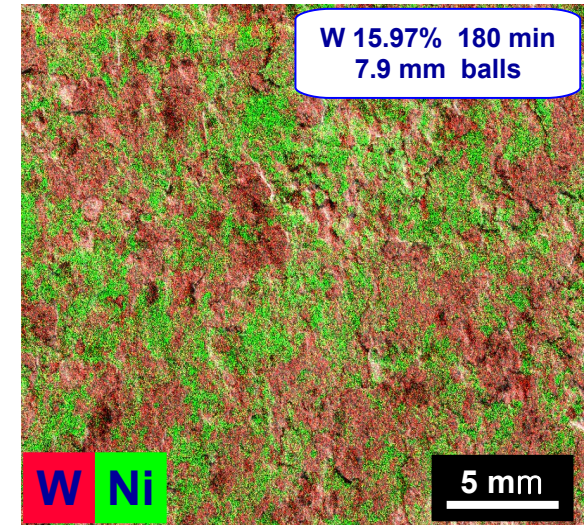
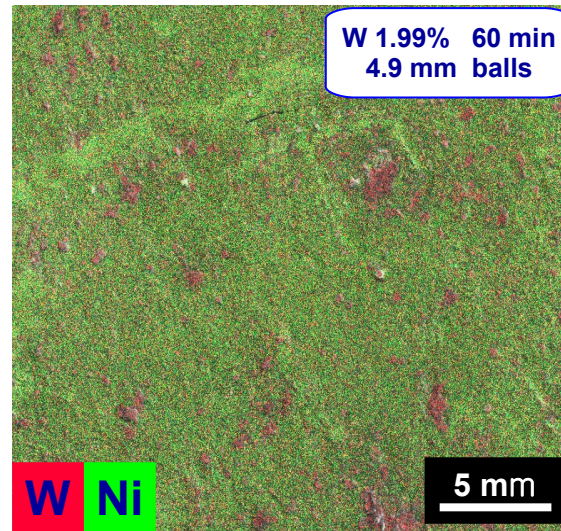
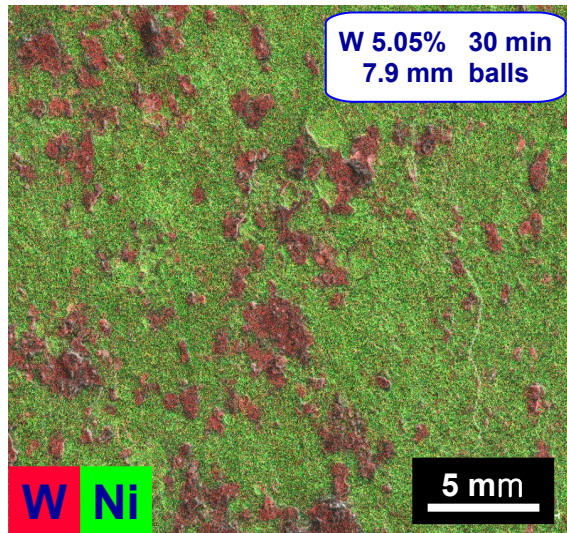
Bending Fatigue



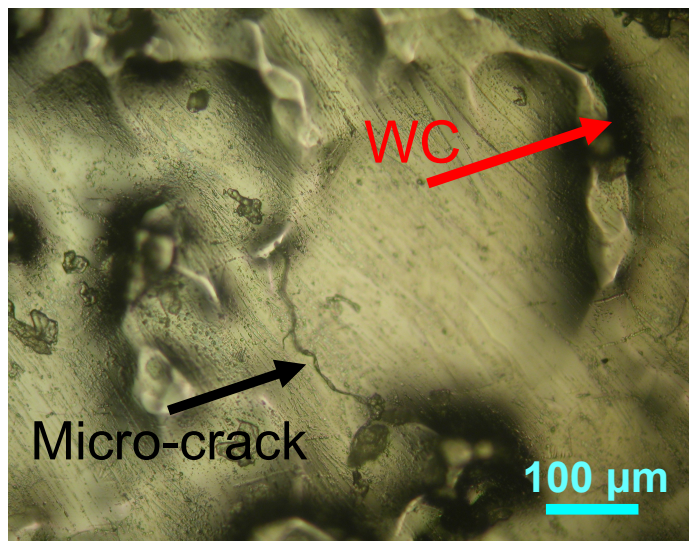
FEM

Effects of Surface Treatments on Crystalline Ni-based C-2000 Superalloy

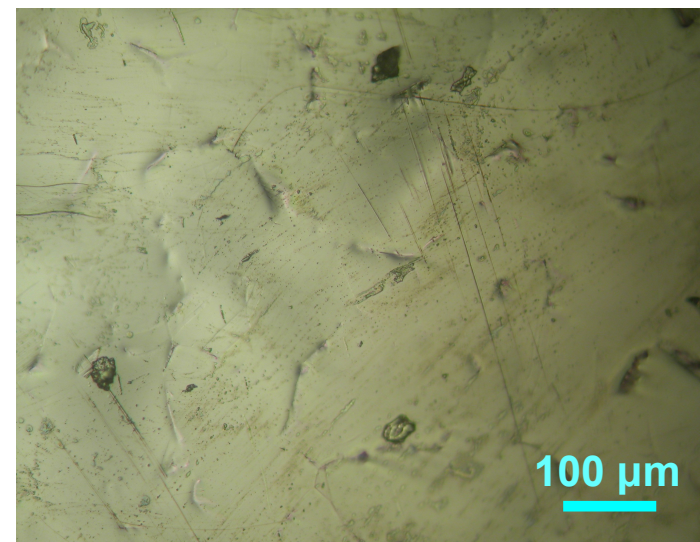
Surface contaminations



Energy Dispersive Spectrum (EDS) mapping of the C-2000 sample surface



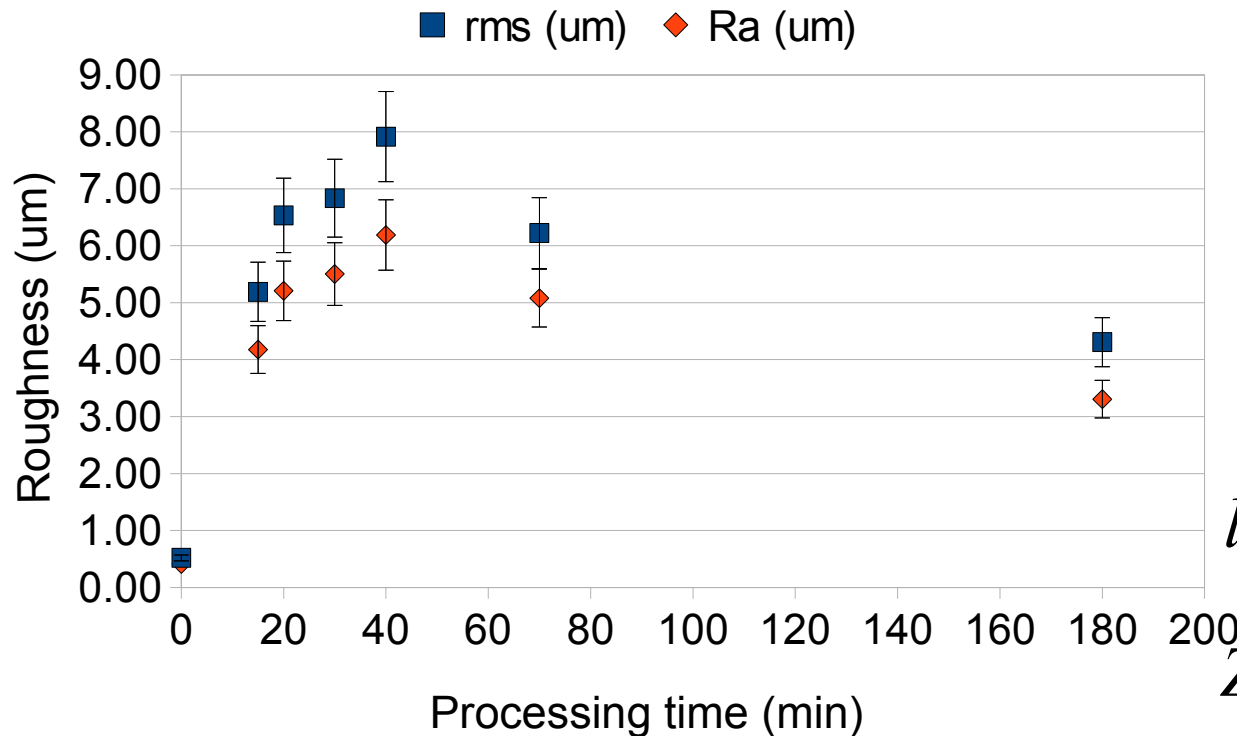
10-um electro-polished away
(micro-crack & residual WC)



25-um polished away

Surface roughness

Surface roughness as a function of processing time



$$R_a = \frac{1}{l_m} \int_{x=0}^{x=l_m} |Z(x)| dx$$

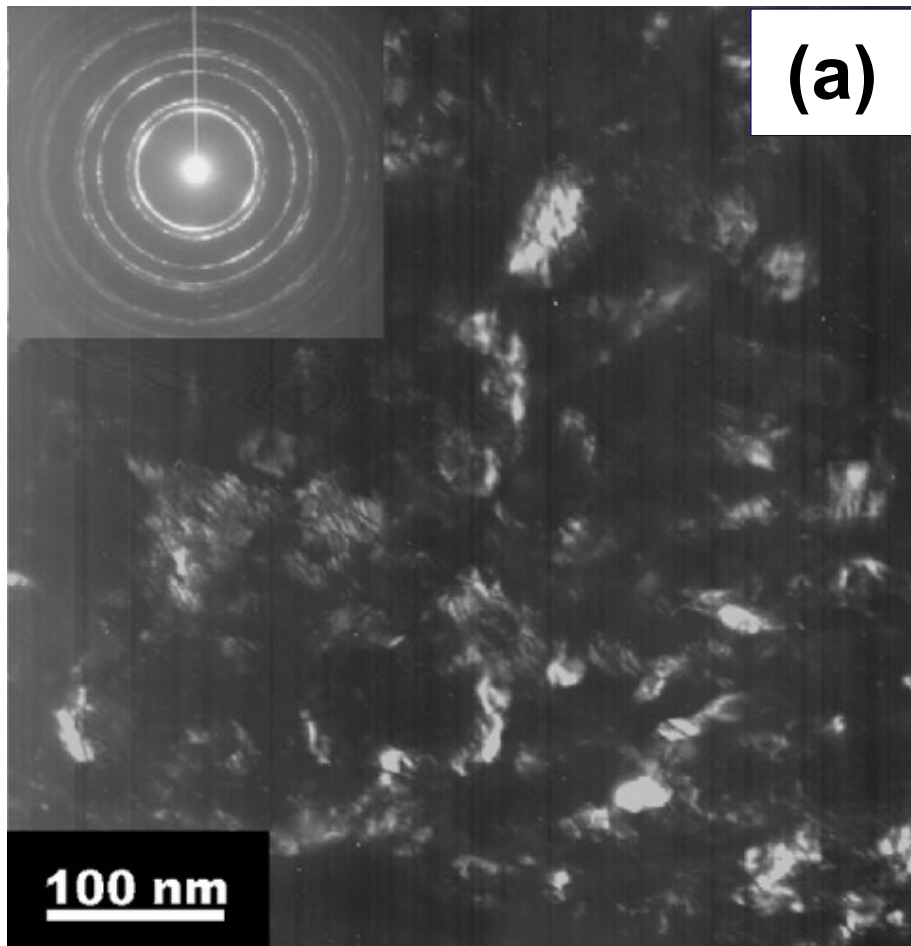
$$rms = \sqrt{\frac{1}{l_m} \int_{x=0}^{x=l_m} Z^2(x) dx}$$

l_m : The length that measured for roughness

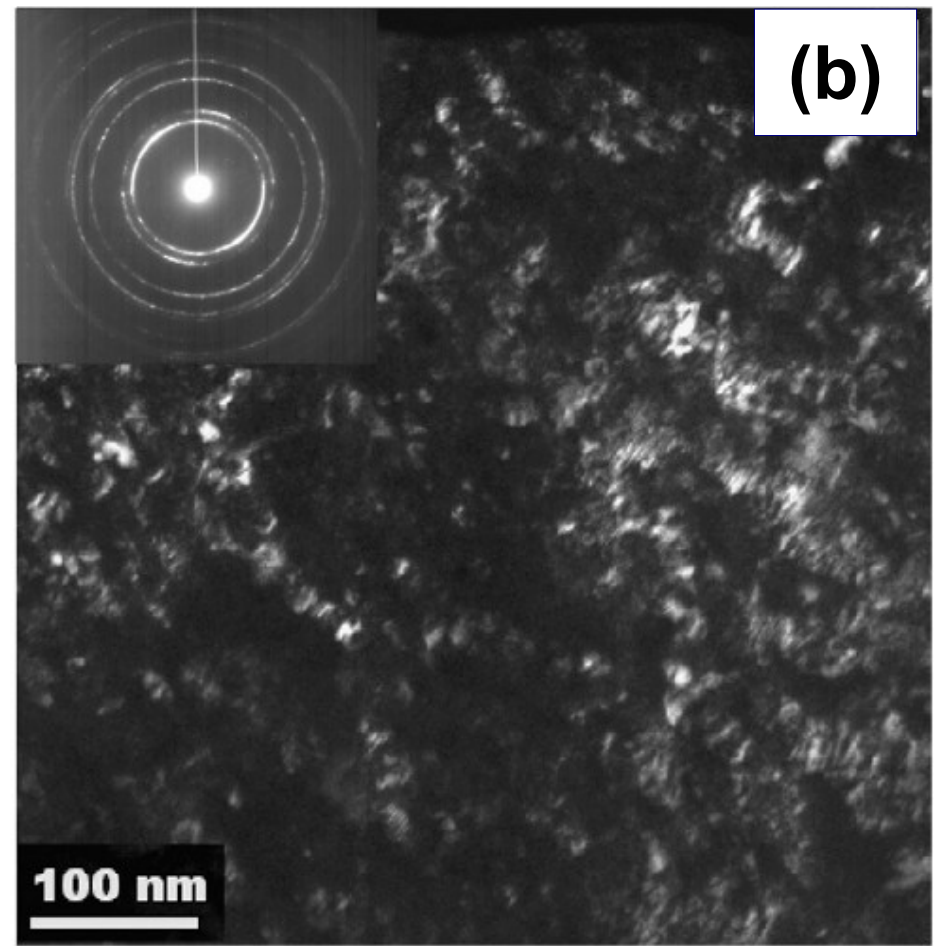
Z_x : The height of a certain point on the surface to the reference point

- Large balls are easier than small balls to induce surface roughness
- Roughness increases first, and then decreases with processing time

TEM dark-field images from surface

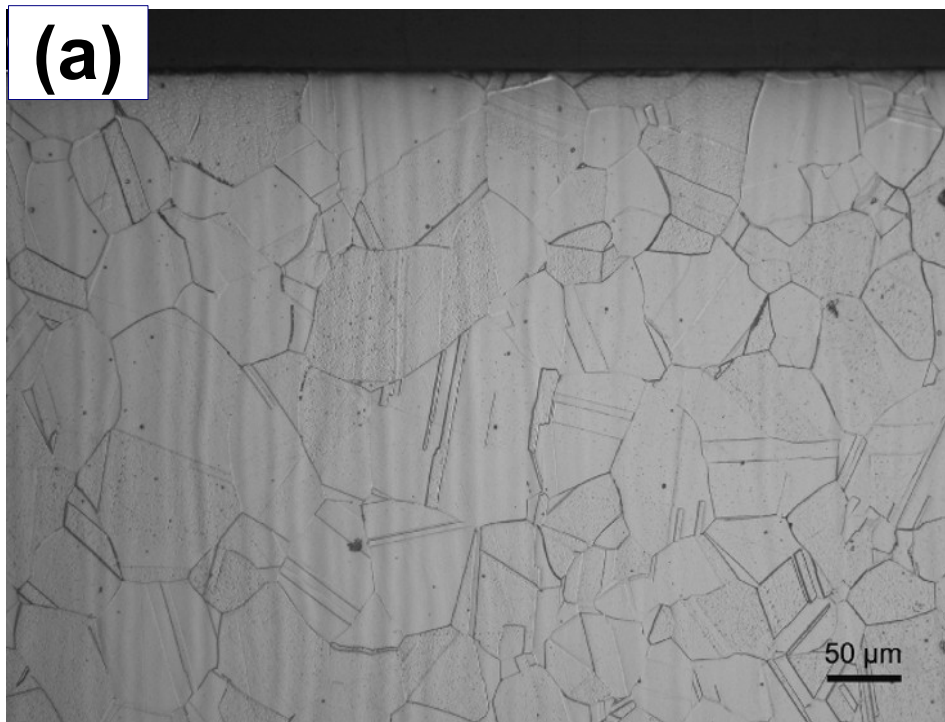


30-min processed

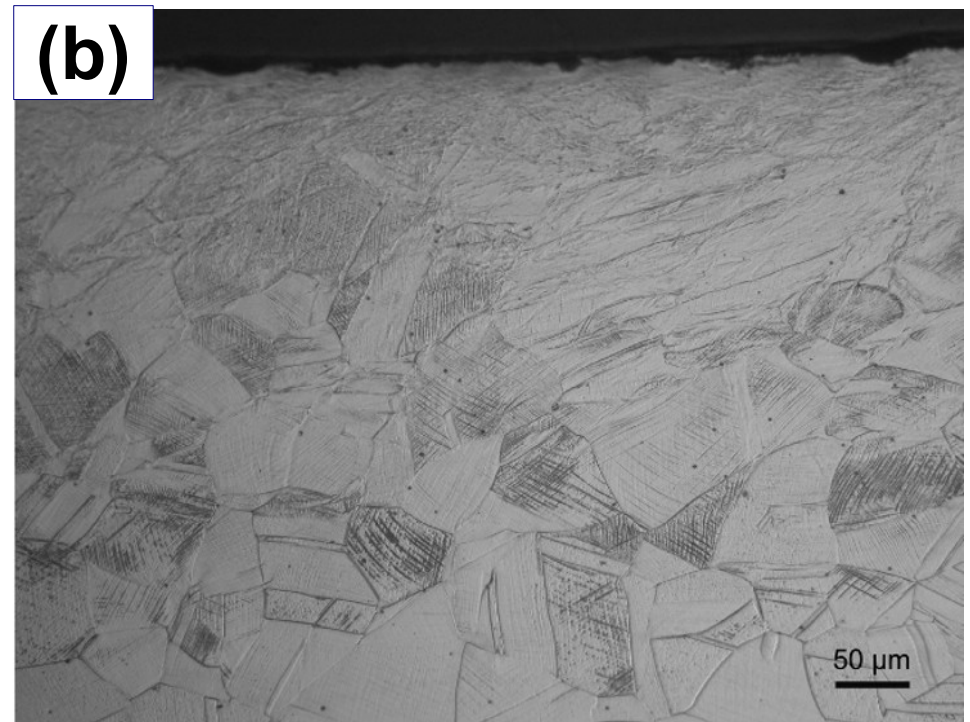


180-min processed

Cross-sectional microstructures



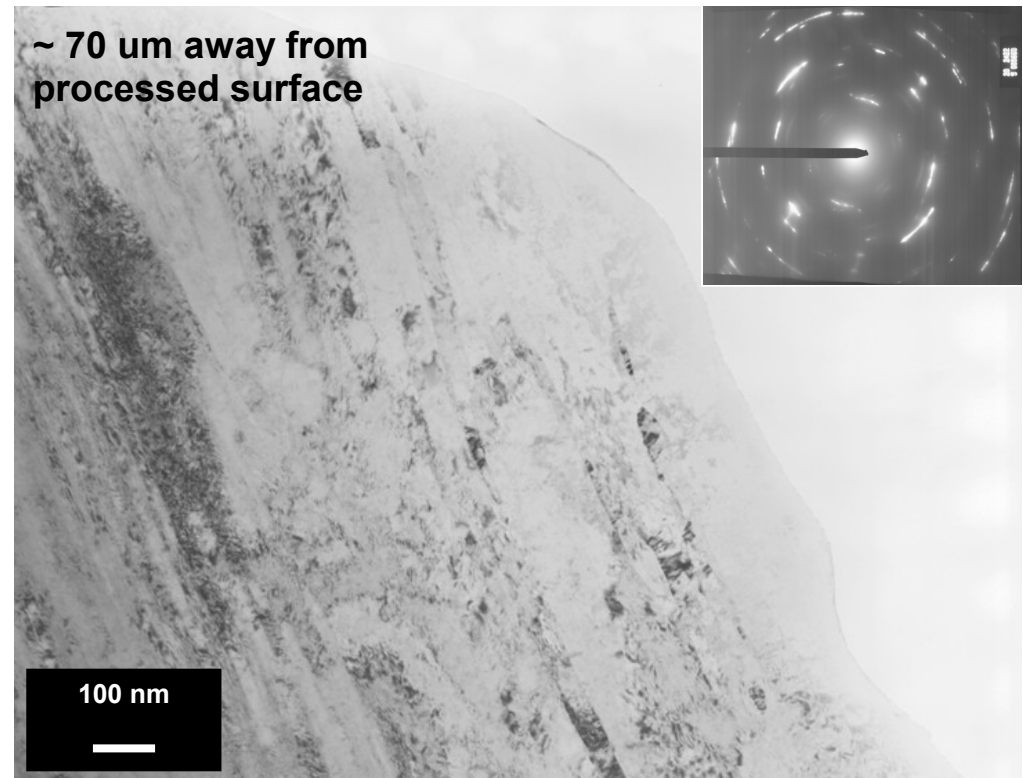
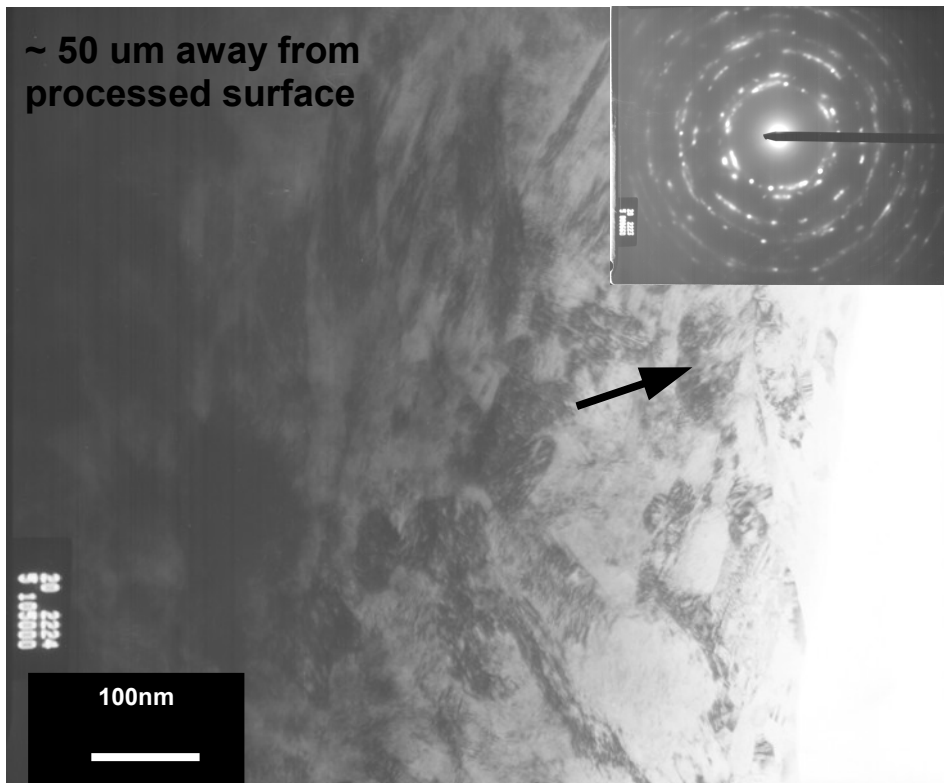
As-received



180-min processed

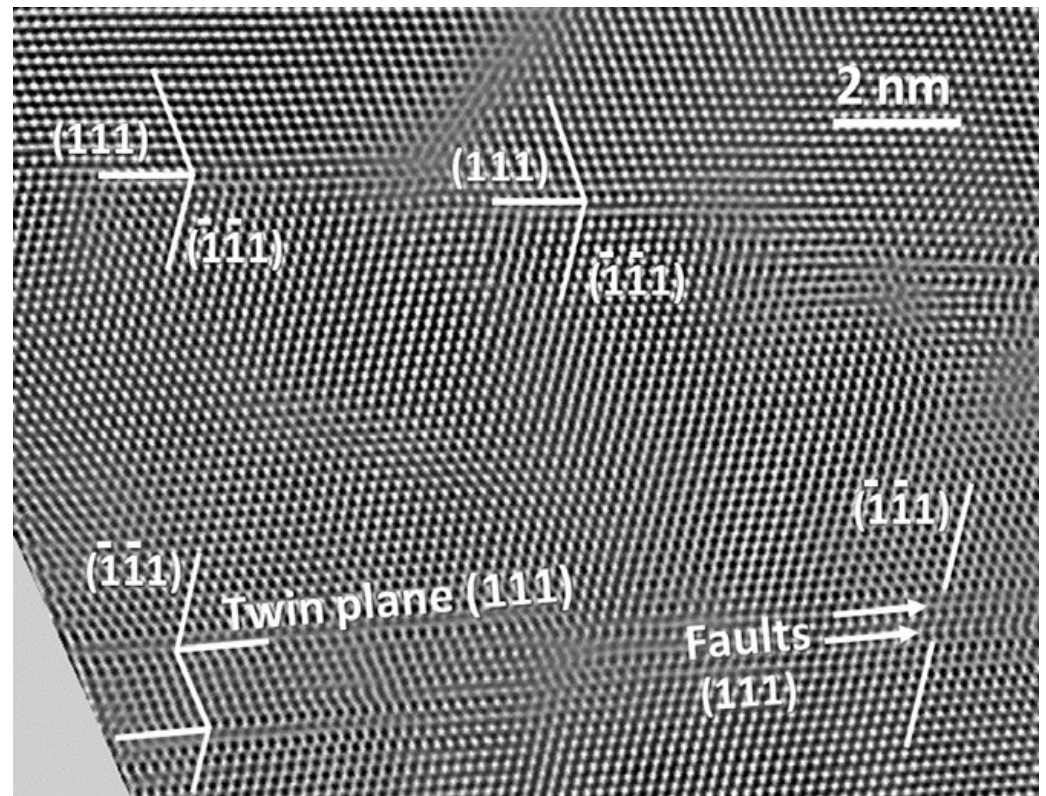
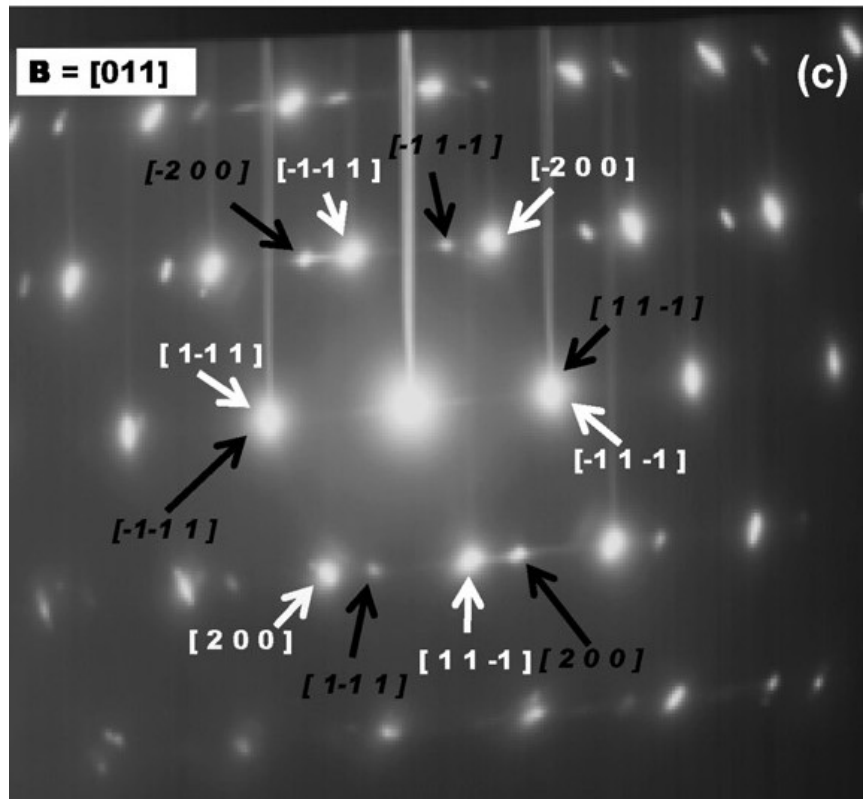
Optical images of the cross-sectional view of (a) the annealed and (b) 180-min S²PD processed C-2000 samples

TEM bright-field images



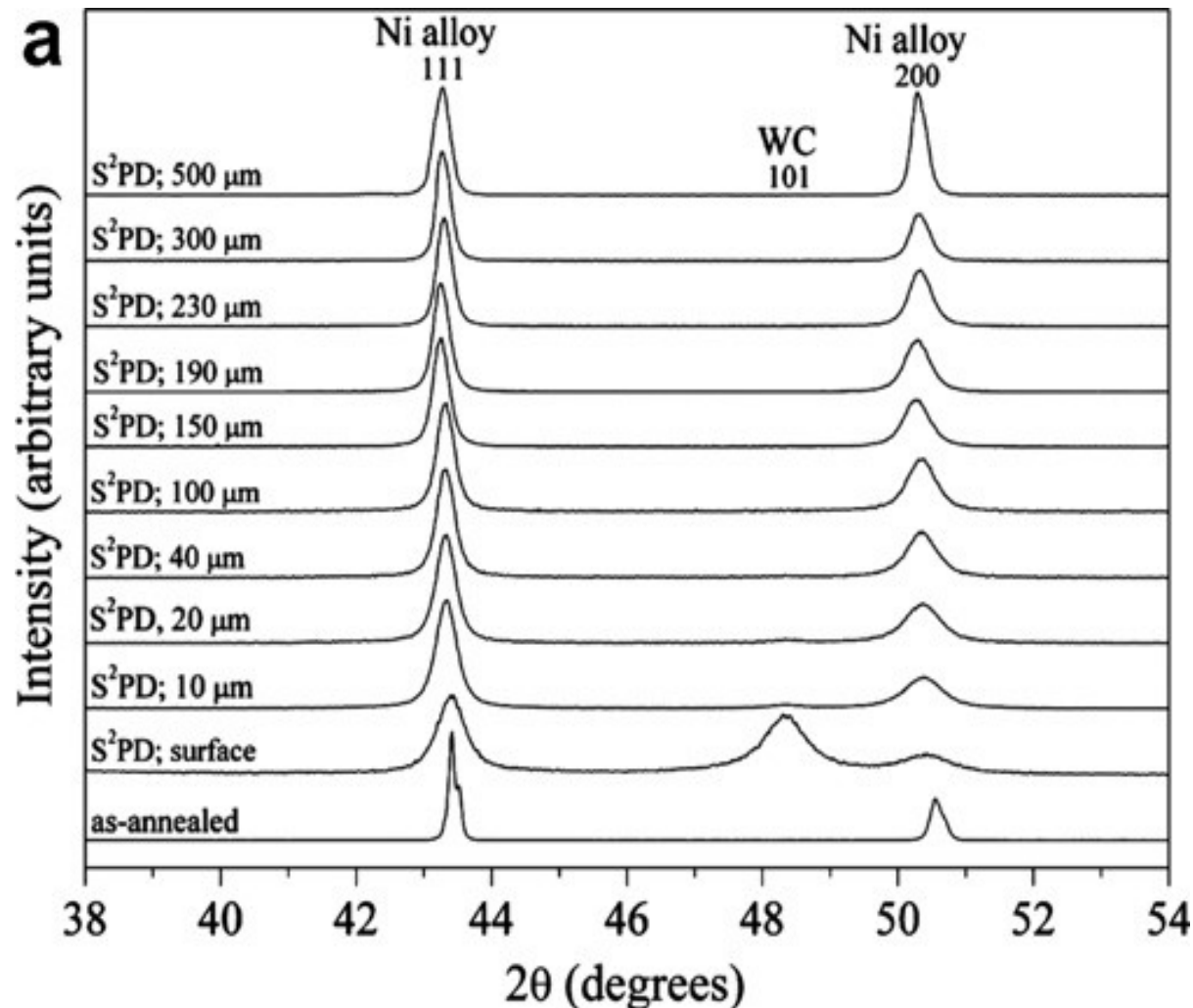
180-min processed C-2000

Confirmation of the deformation twins via SAD and HRTEM*



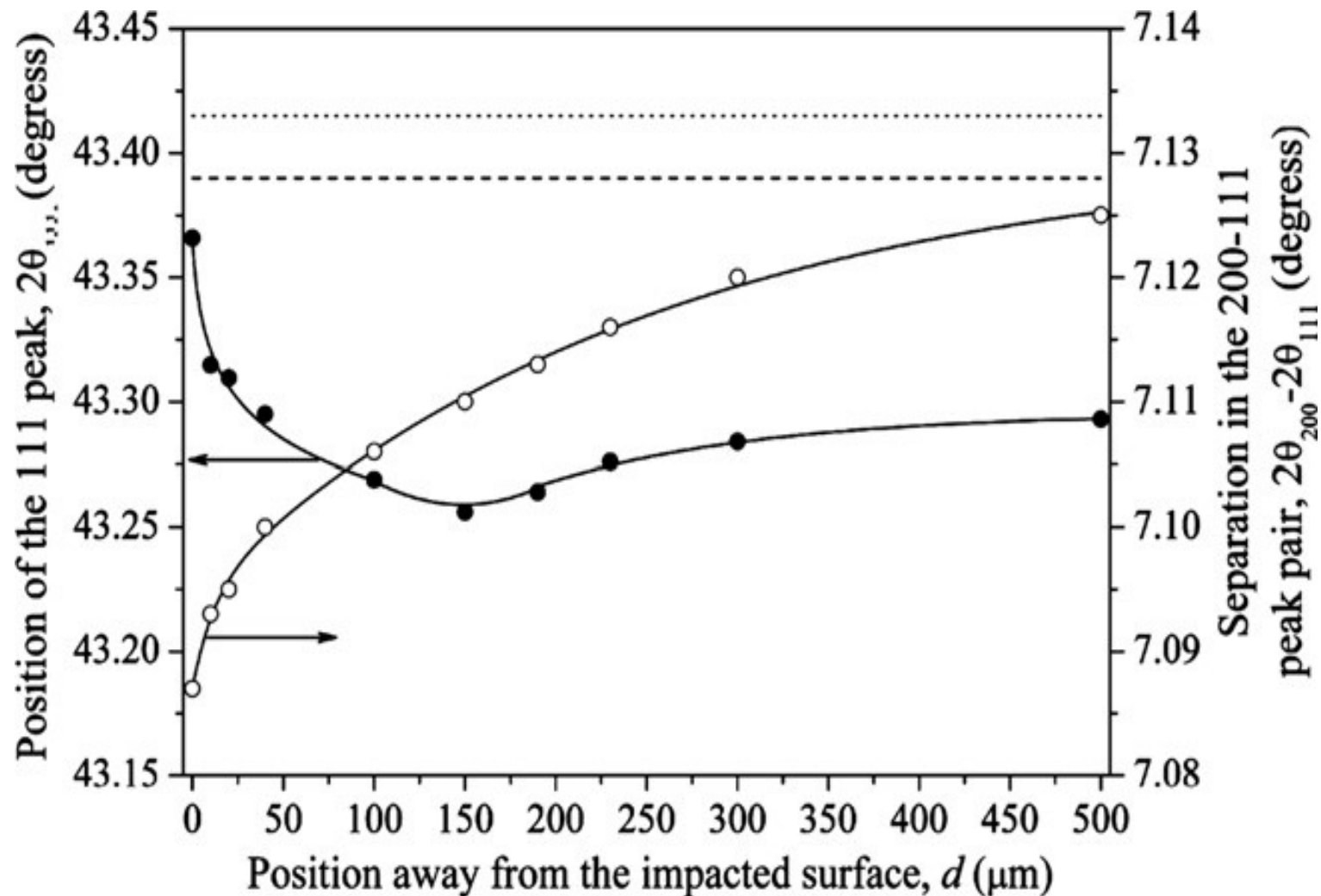
The deformation twins were identified by two symmetrical sets of diffraction patterns with respect to the $\{111\}$

XRD from different positions (layer-by-layer electro-polishing)



XRD patterns for C-2000 alloy as a function of distance to the impacted surface. (Processing time: 180 min, Sample size: 20 X 20 mm²)

Peak position varies along depth



A slide supposed to be skipped ...

$$\gamma = \frac{\sqrt{3}\pi 2\theta^r (I^{2\theta_l} - I^{2\theta_r})}{2\beta} \left(1 + \left[\frac{\lambda}{4\pi D_{\text{eff},200}(\sin \theta^r - \sin \theta_{B,200})} \right]^2 \right)$$

$$\Delta_f(2\theta) = 2\theta_0 - 2\theta_B = \frac{90\sqrt{3}C_f \tan \theta_0}{\pi^2} \alpha$$

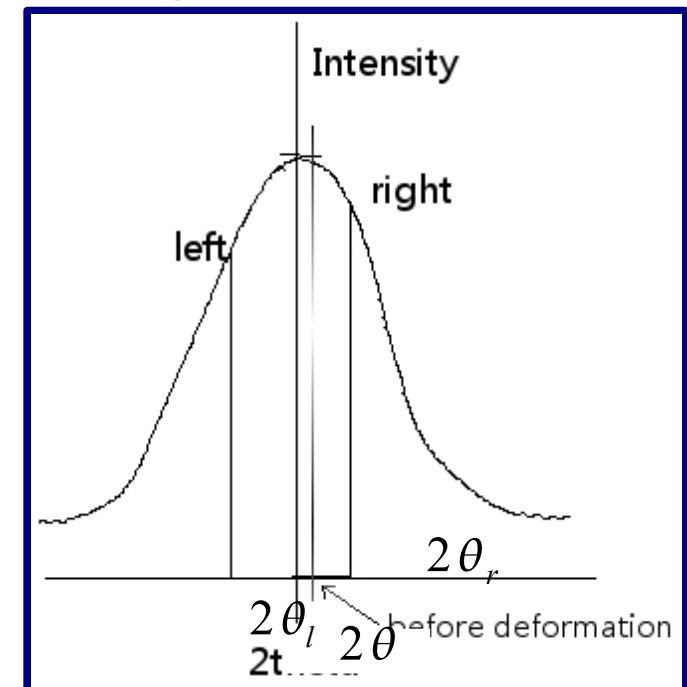
$$\alpha = \frac{\pi^2 [\Delta_f(2\theta_1 - 2\theta_2)]}{90\sqrt{3}(C_{f,1} \tan \theta_1 - C_{f,2} \tan \theta_2)}$$

$$a = \frac{\lambda \sqrt{h^2 + k^2 + l^2}}{2 \sin(\theta_0 - \Delta_f(2\theta)/2)}$$

$$\varepsilon = \frac{d_0 - d_0^R}{d_0^R} = \frac{\sin \theta_0^R - \sin(\theta_0 - \Delta_f(2\theta)/2)}{\sin(\theta_0 - \Delta_f(2\theta)/2)}$$

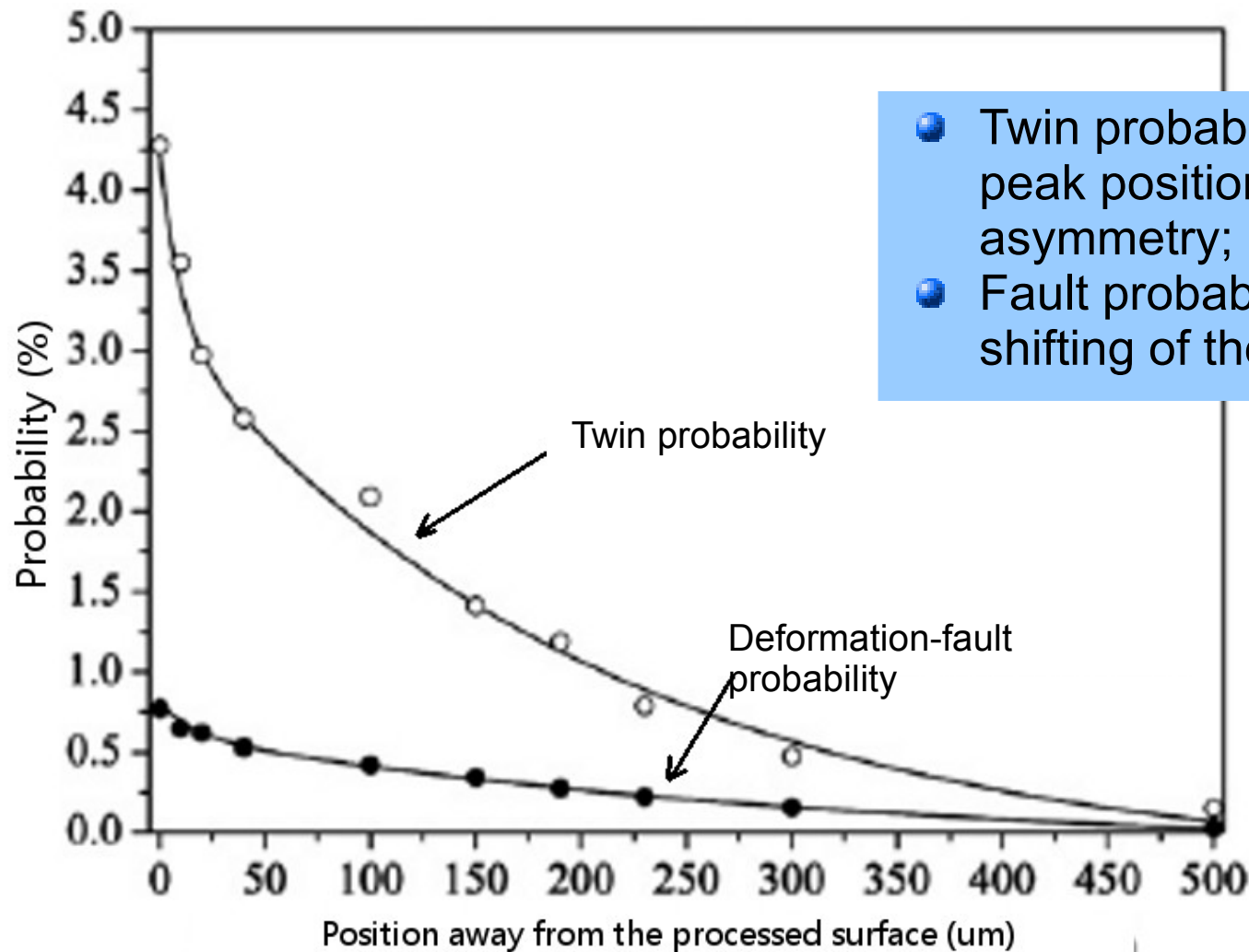
$$D_{\text{eff}} = \frac{90K_K \lambda}{\pi(\beta_L - \beta_L^R) \cos \theta_0}$$

$$D = \frac{K_K D_{\text{eff}} a}{K_K a - (1.5\alpha + \gamma) C_D D_{\text{eff}}}$$



$$\sigma_{||} = -\frac{E}{2\nu} \varepsilon$$

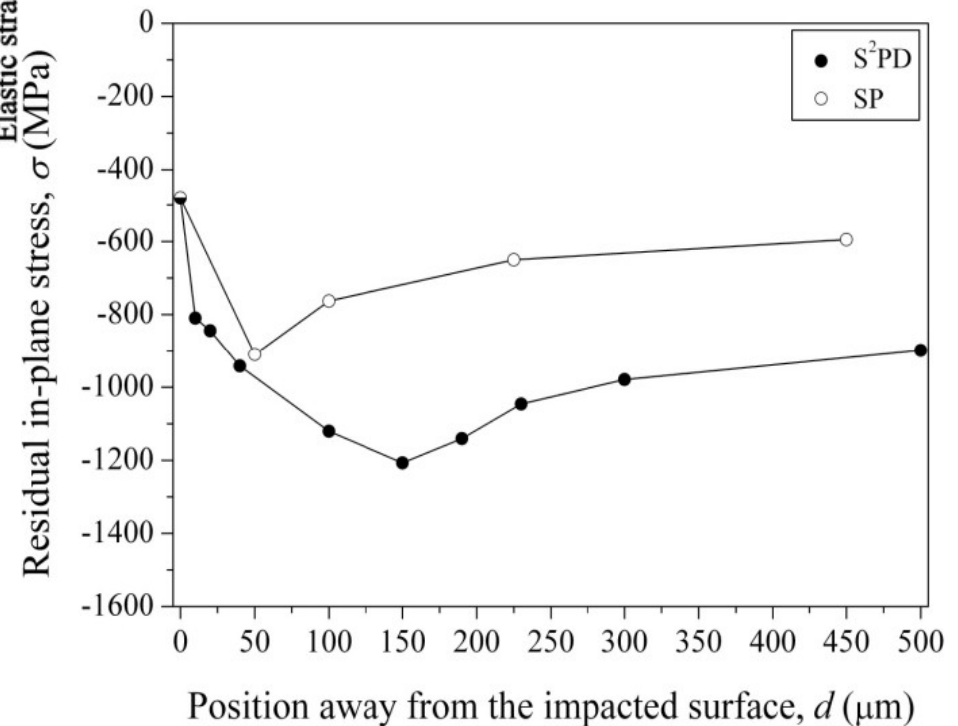
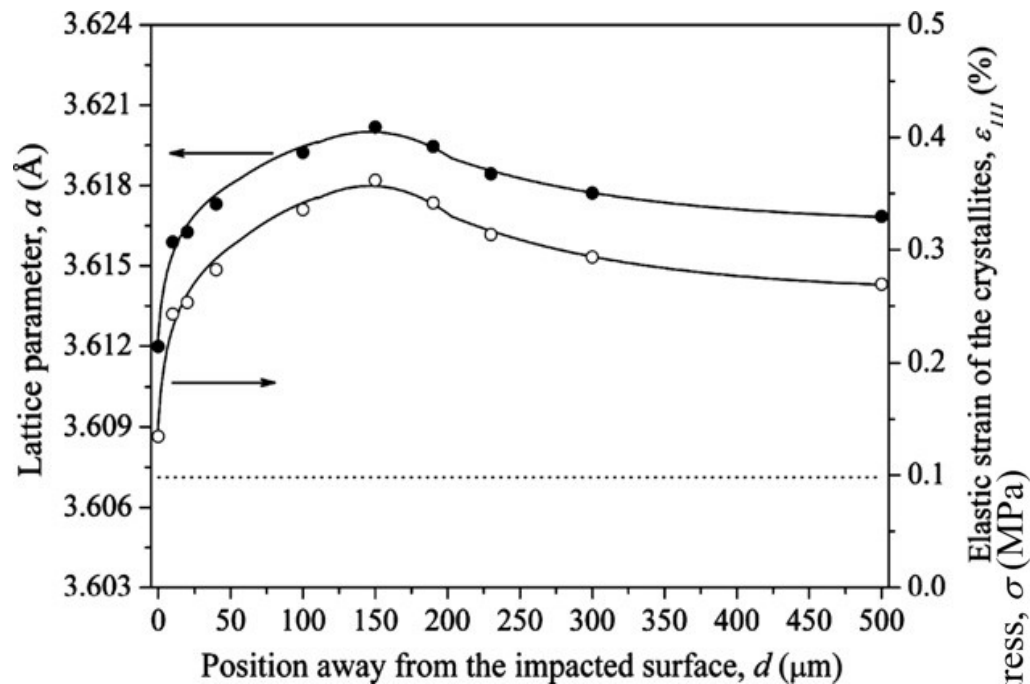
Results from XRD: twins and faults



- Twin probability (γ) – determined by peak position, intensity, and the asymmetry;
- Fault probability (α) – determined by shifting of the neighboring peak pairs;

Twin and deformation fault probabilities of the 180 min processed sample as a function depth from surface

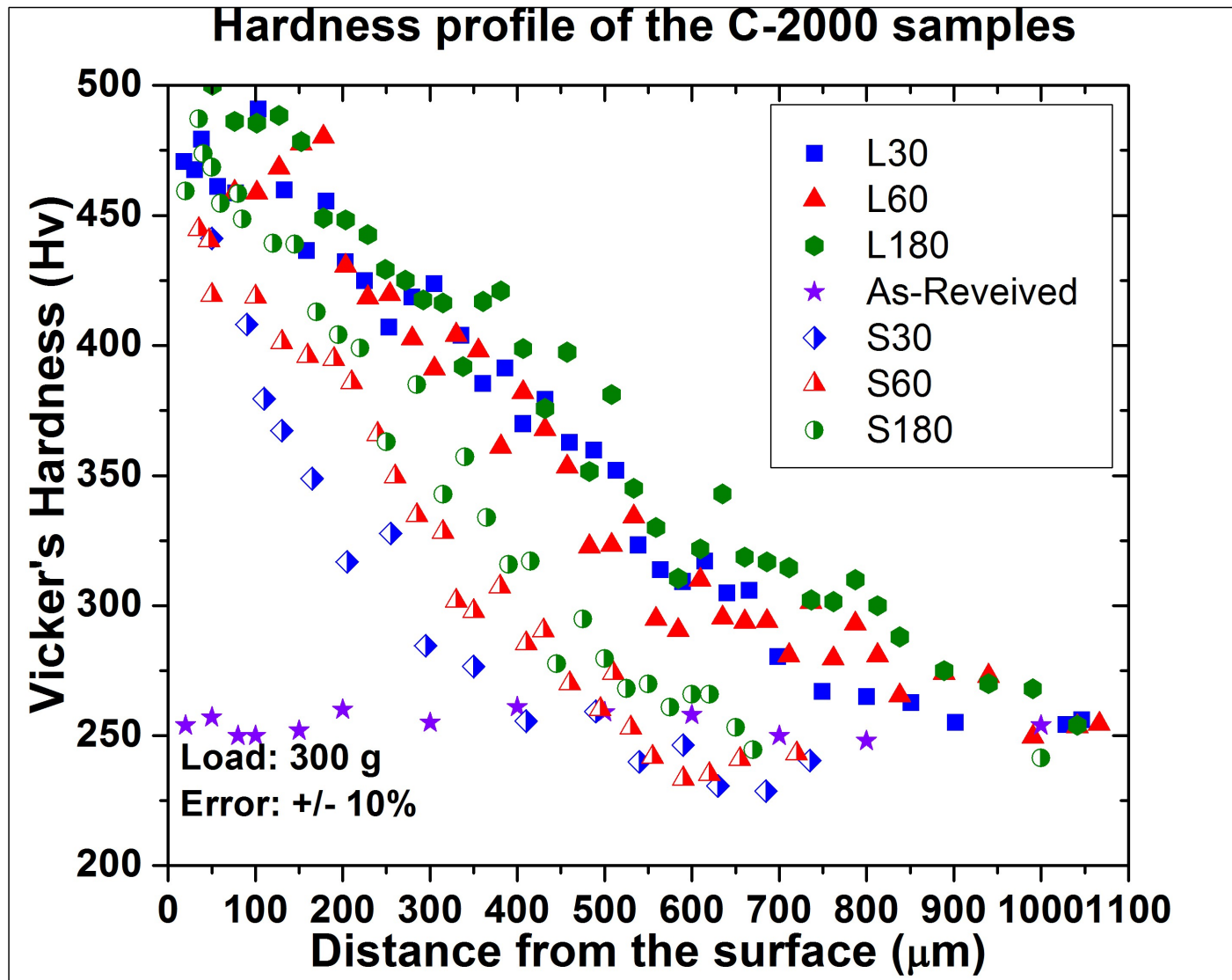
Results from XRD: residual stresses



✗ (i) Formation of solid solutions with C and/or W atoms as solutes in the C-2000 alloy matrix

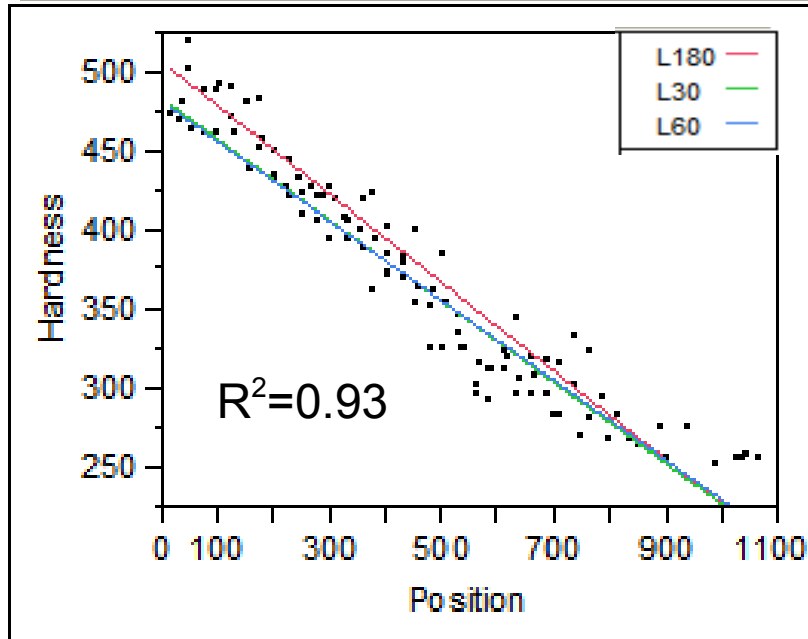
✓ (ii) Introduction of macroscopic residual in-plane compressive stresses

Hardness profiles



Statistical analysis on hardness

Regression Plot



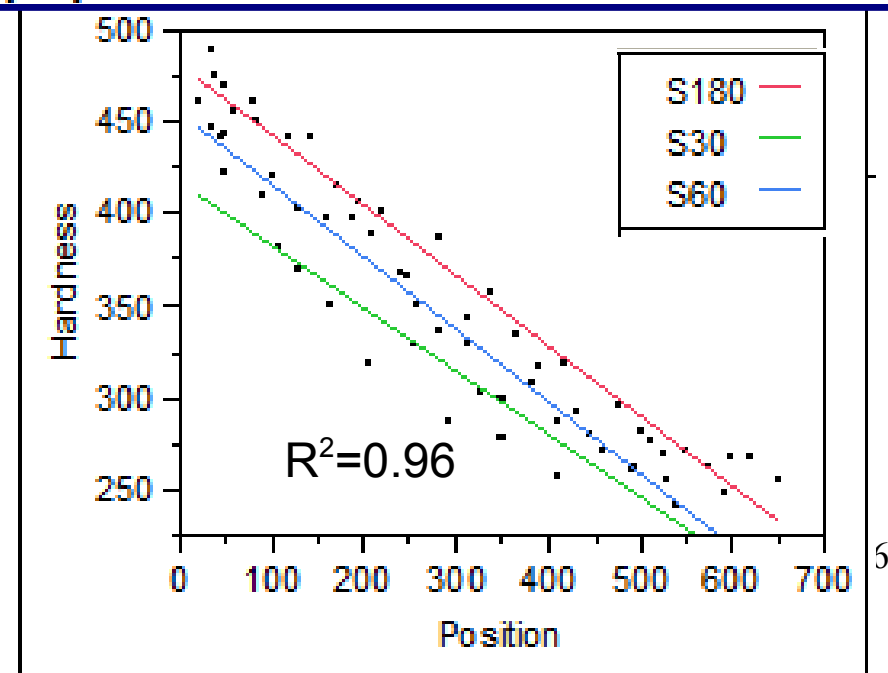
Parameter Estimates

Term	Estimate	Std Error	t Ratio	Prob> t
Intercept	489.80243	4.002434	122.38	<.0001*
Position	-0.262353	0.00793	-33.09	<.0001*
Group[L180]	17.076517	6.052536	2.82	0.0058*
Group[L30]	-7.648758	5.318255	-1.44	0.1536

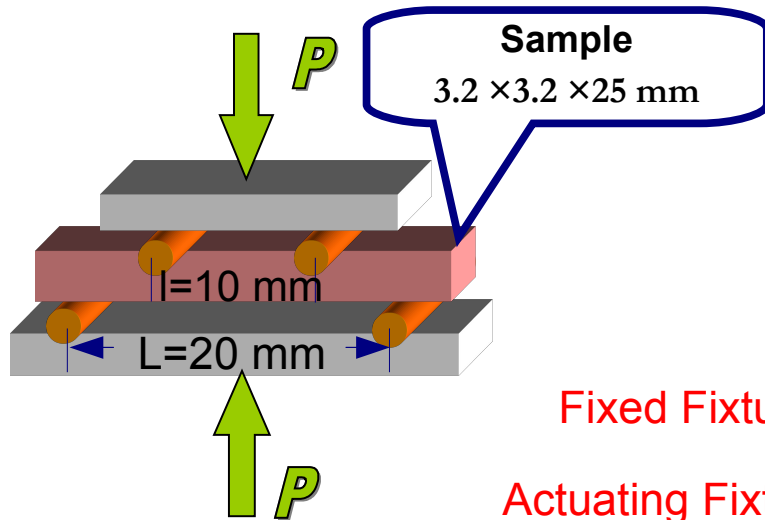
Parameter Estimates

Term	Estimate	Std Error	t Ratio	Prob> t
Intercept	450.37537	3.999357	112.61	<.0001*
Position	-0.372362	0.011982	-31.08	<.0001*
Group[S180]	30.603856	5.02413	6.09	<.0001*
Group[S30]	-34.10579	6.199464	-5.50	<.0001*

- No significant difference in slope;
- No significant difference between intercepts of L30 and L60, though L180 has a little higher intercept
- Significant difference in intercepts for S
- Indication of saturated bombardment for 7.9 mm balls but not unsaturated for 4.9 mm balls



Four-point-bending fatigue



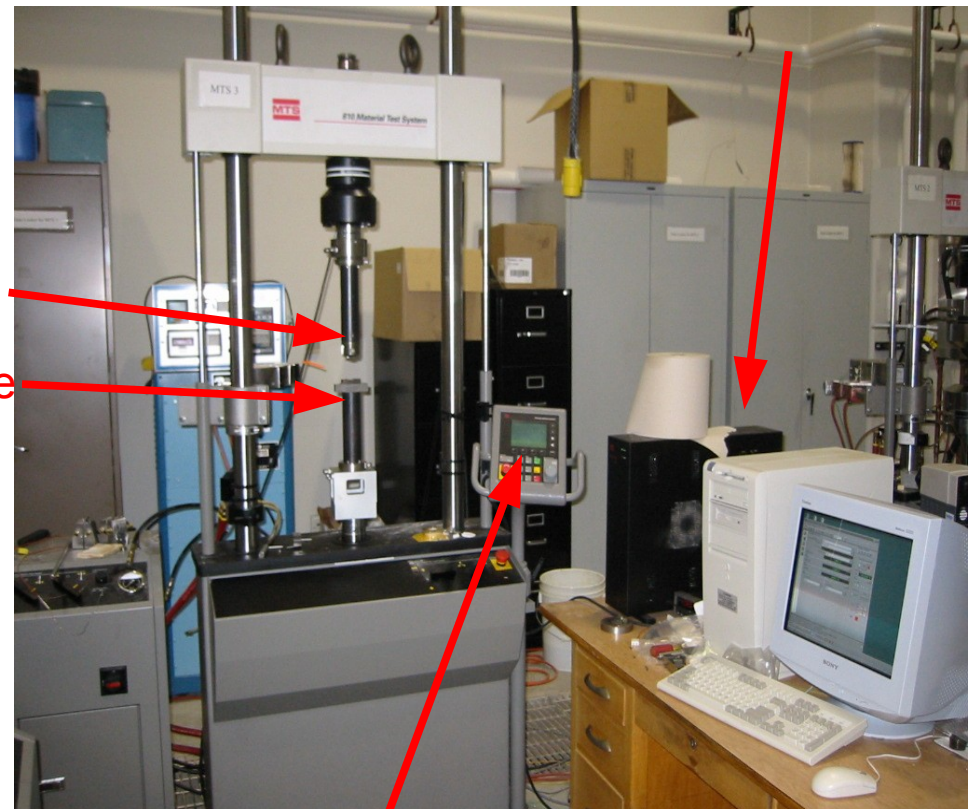
$$\sigma = \frac{3P(L-l)}{2Wh^2}$$

$$R = \frac{\sigma_{min}}{\sigma_{max}} = 0.1$$

P: load
W: width
h: height

σ : stress
R: stress ratio

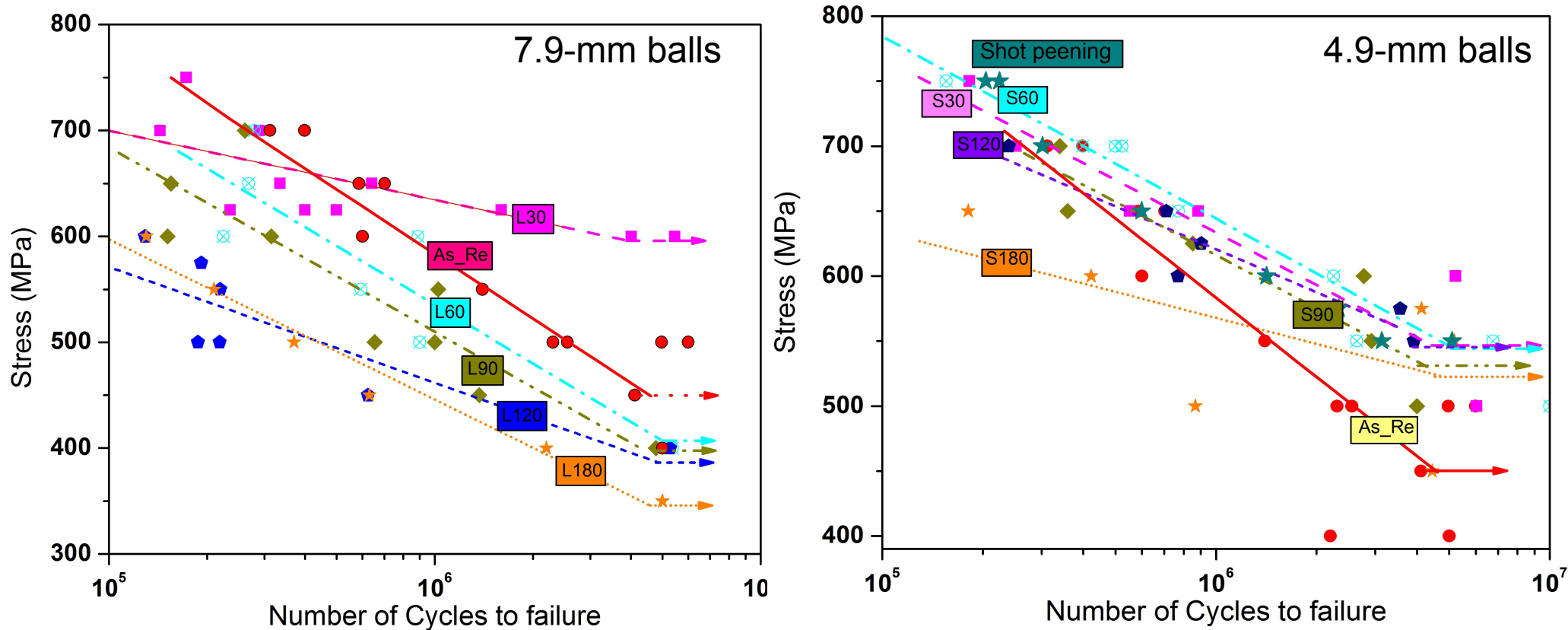
Fixed Fixture
Actuating Fixture



Control system

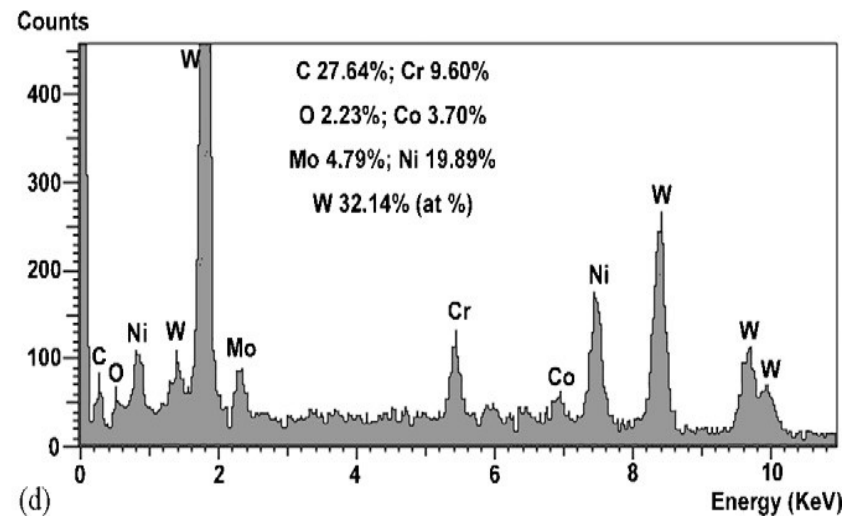
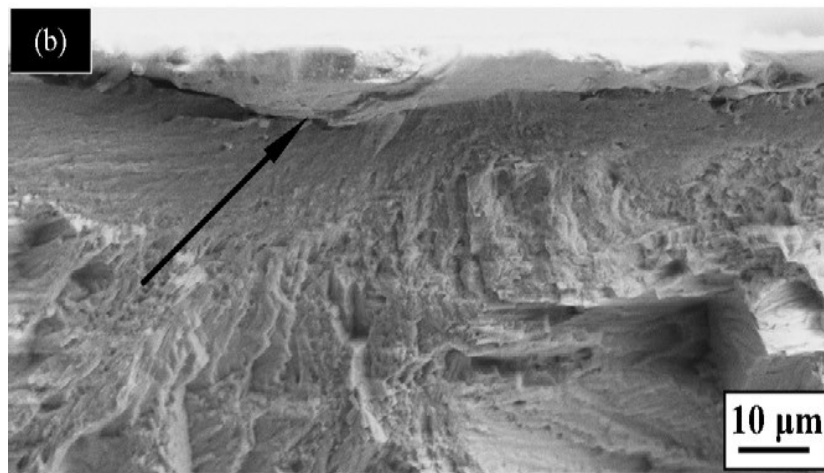
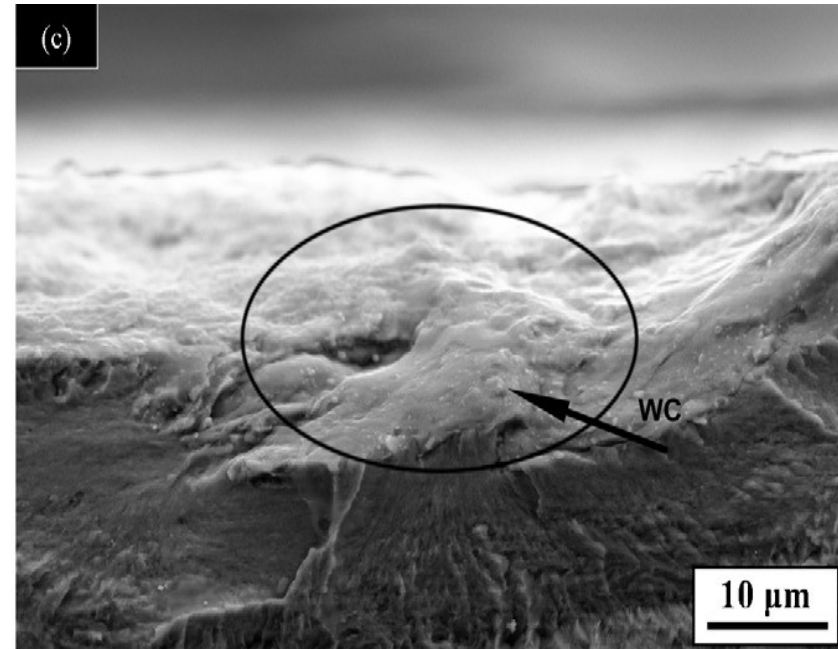
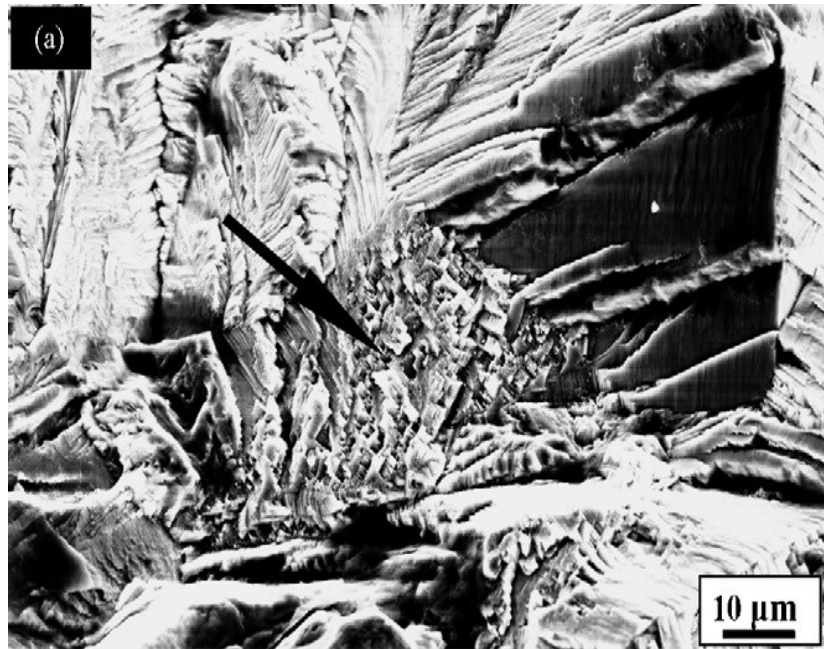
Manual Control Panel

S-N curves



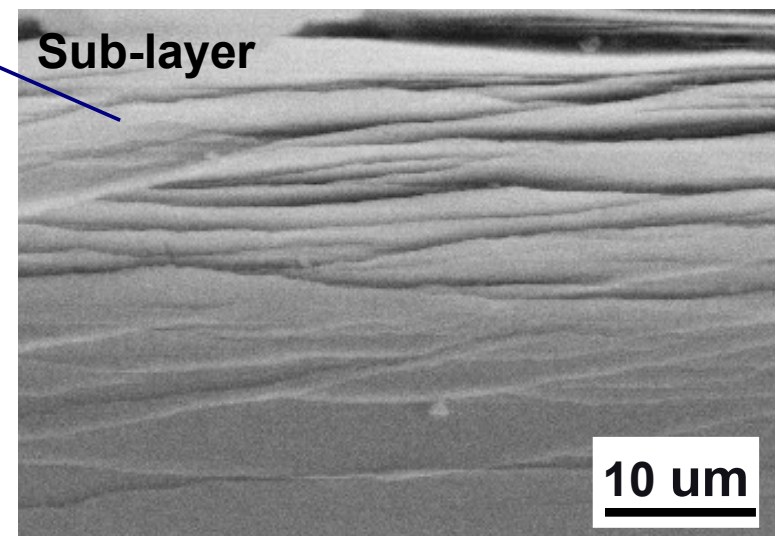
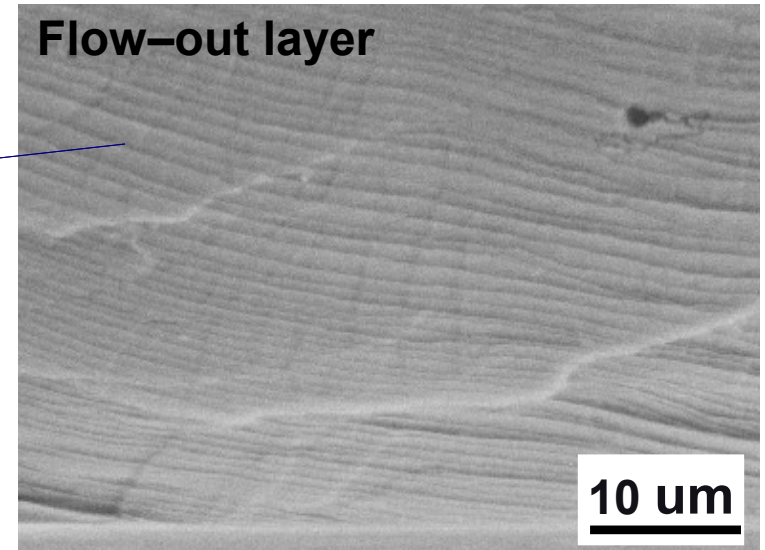
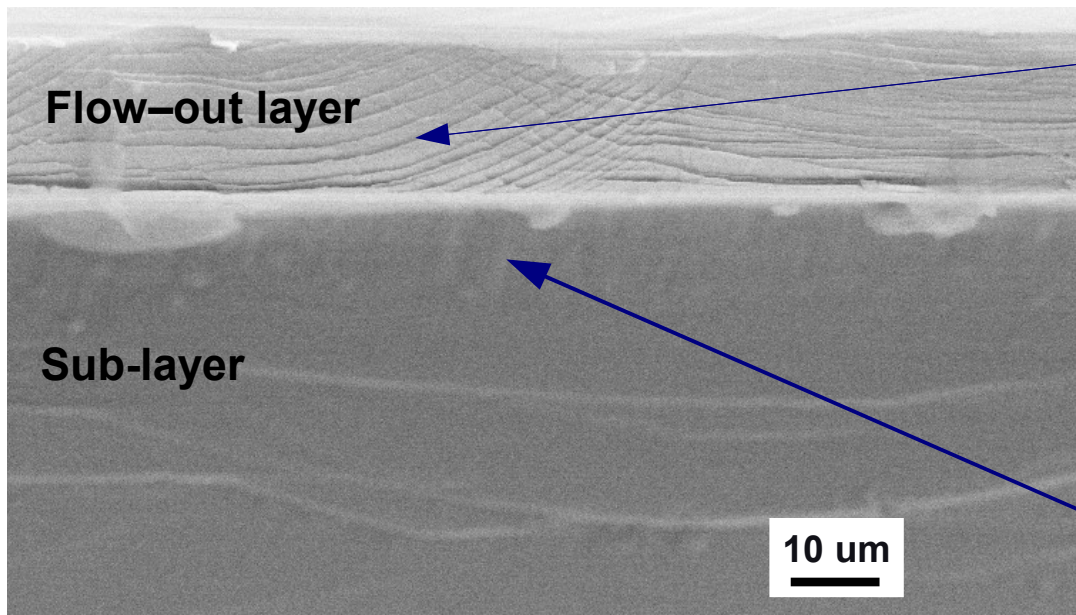
- The fatigue performance of the sample processed with 7.9-mm balls decreases with the processing time;
- The fatigue performance of the sample processed with 4.9-mm balls does not show much difference with time, and all strengths are higher than that of the as-received sample;

Fatigue fractography



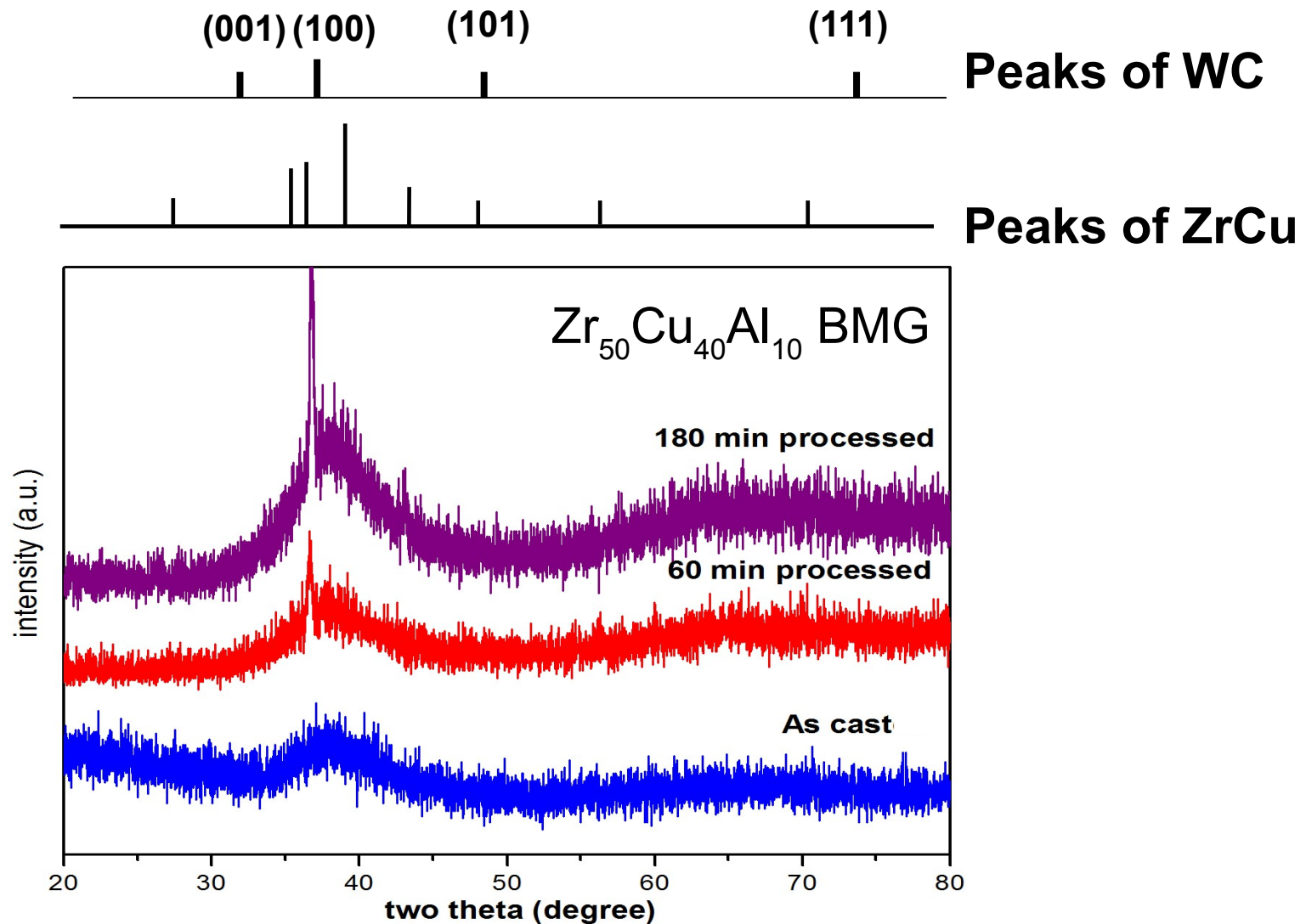
Effects of Surface Treatment on Amorphous Zr-based $\text{Zr}_{50}\text{Cu}_{40}\text{Al}_{10}$ Bulk Metallic Glass

Side View of the Deformed Surface Layer



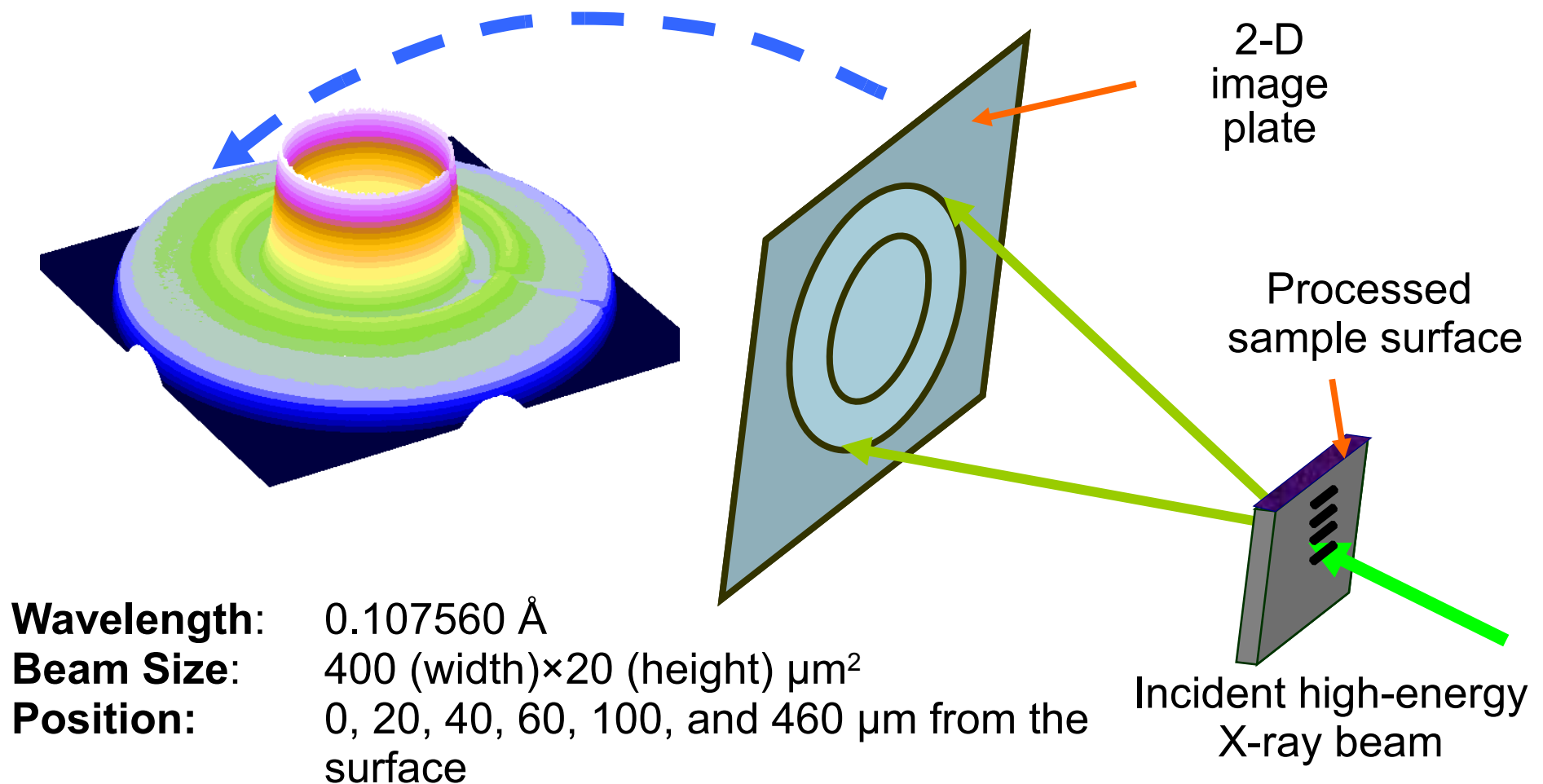
180-min-Processed $\text{Zr}_{50}\text{Cu}_{40}\text{Al}_{10}$

XRD from the Processed Surface



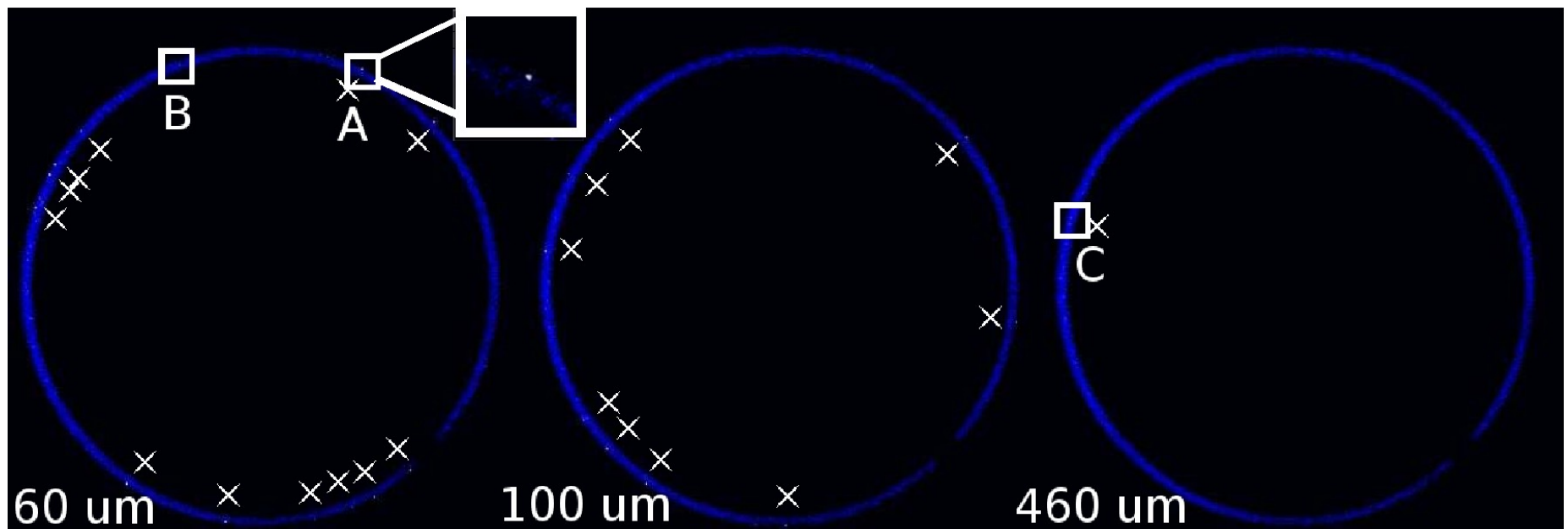
Crystal phase appears after the surface treatment process

Synchrotron high-energy XRD from the side surface*



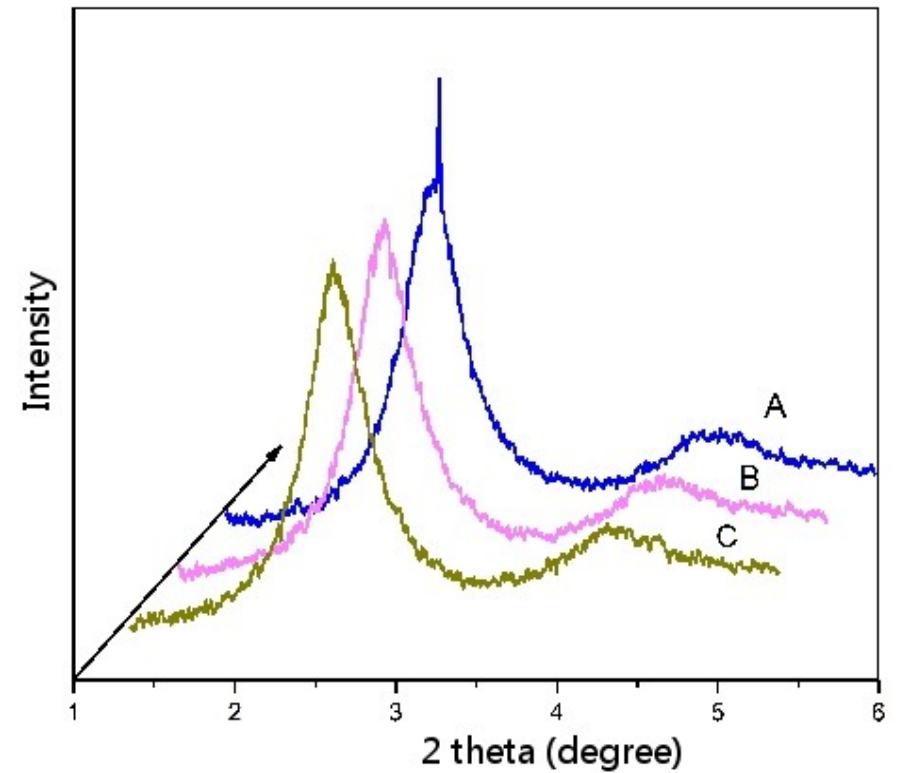
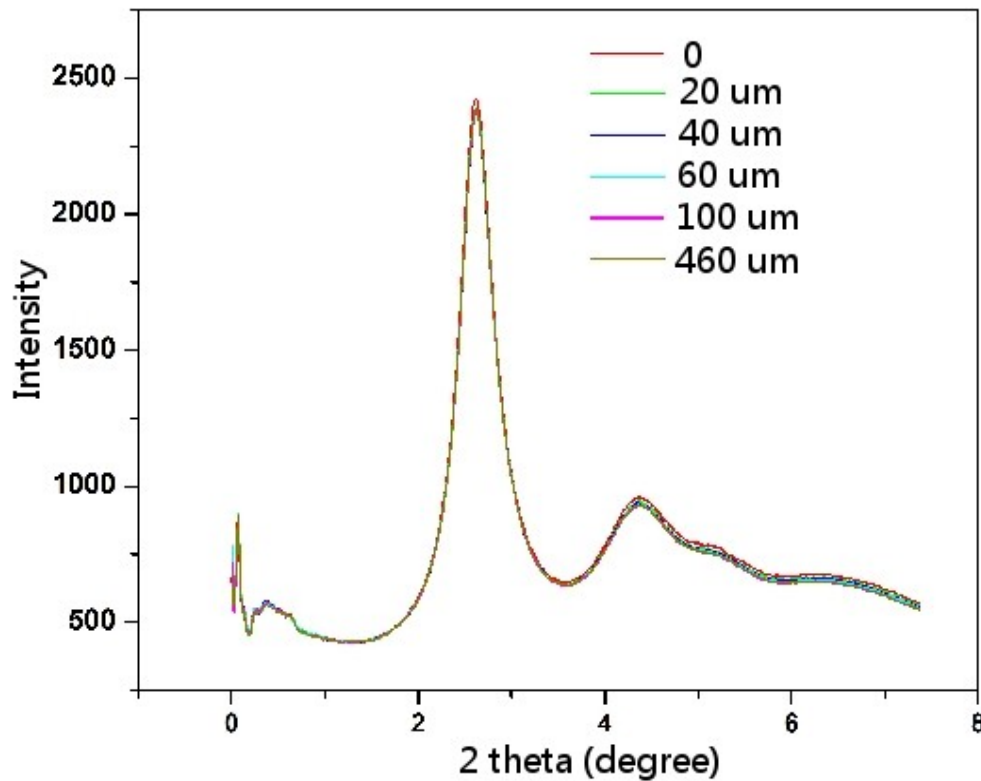
*Conducted at the Advanced Photon Source (APS), **Argonne National Laboratory**

2-D Synchrotron high-energy x-ray patterns at different positions

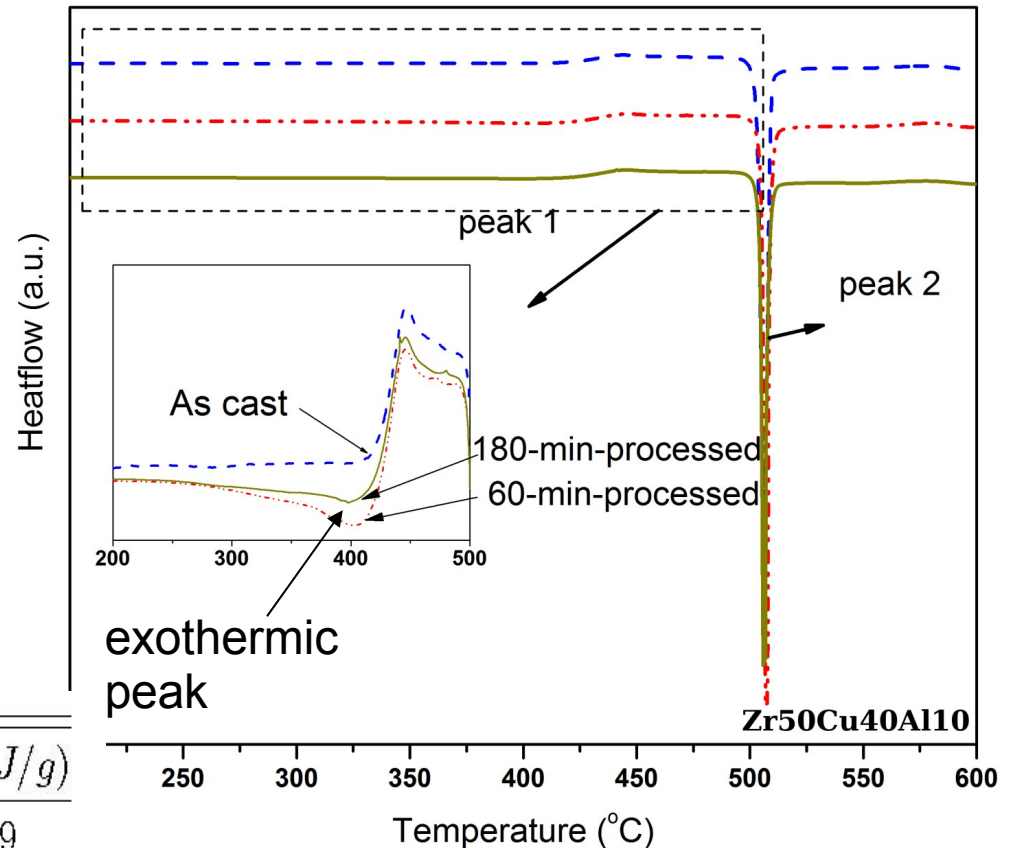
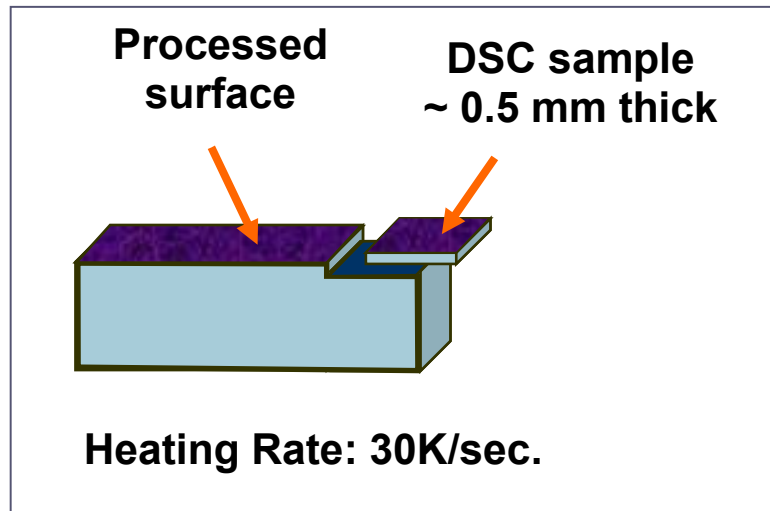


Relative amount of crystal phases becomes less and less when the position moves from processed surface to the interior

Integrated 1-D synchrotron high-energy X-ray spectra



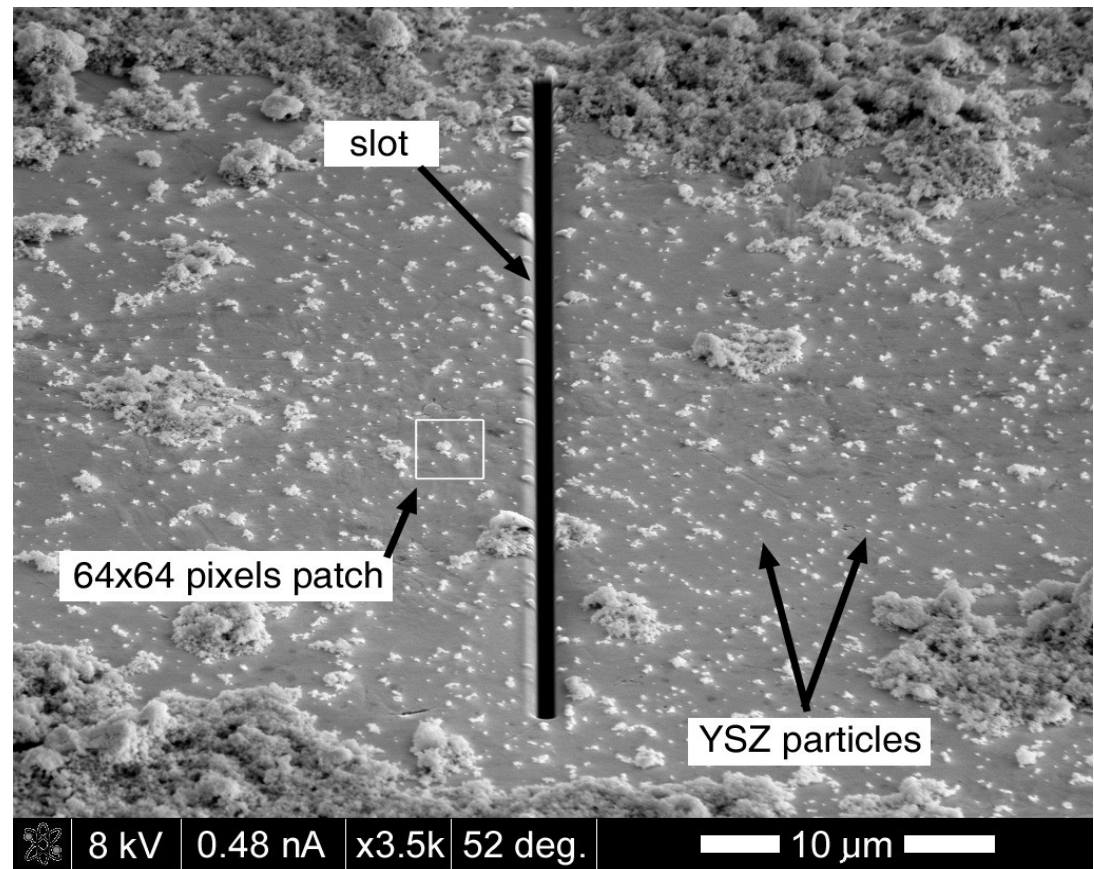
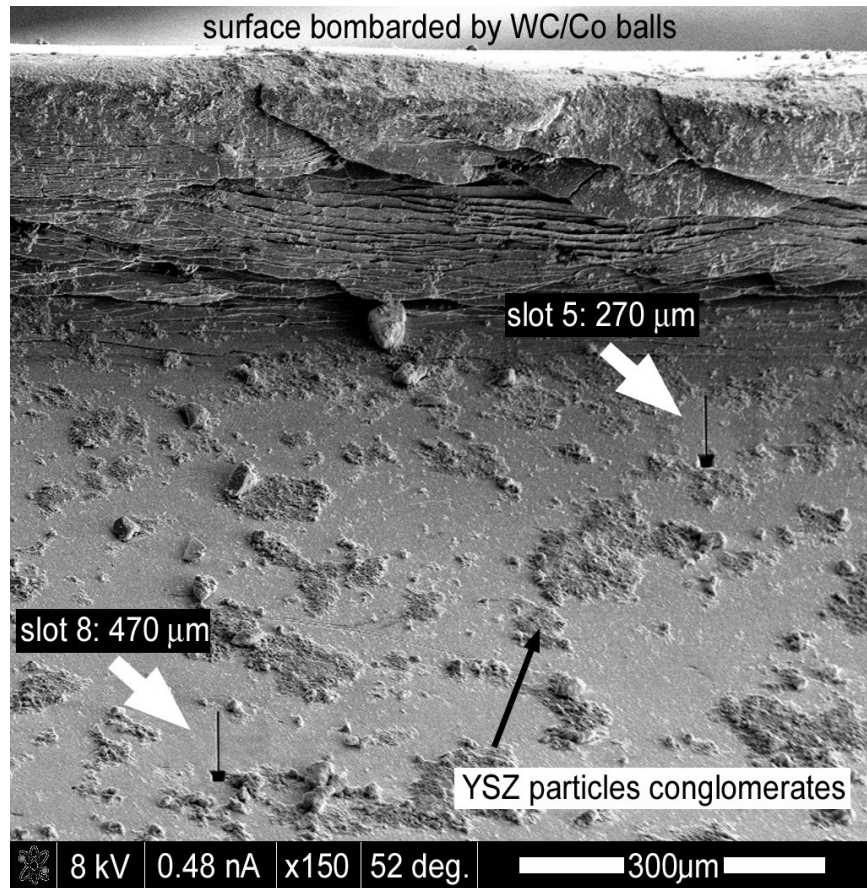
Differential-Scanning Calorimetry (DSC)



Sample	$T_g(^{\circ}\text{C})$	$T_x(^{\circ}\text{C})$	$\Delta H_2(\text{J/g})$
As-Cast	422.8	501.9	45.9
60 min	421.7	502.3	42.7
180 min	420.5	504.0	36.4

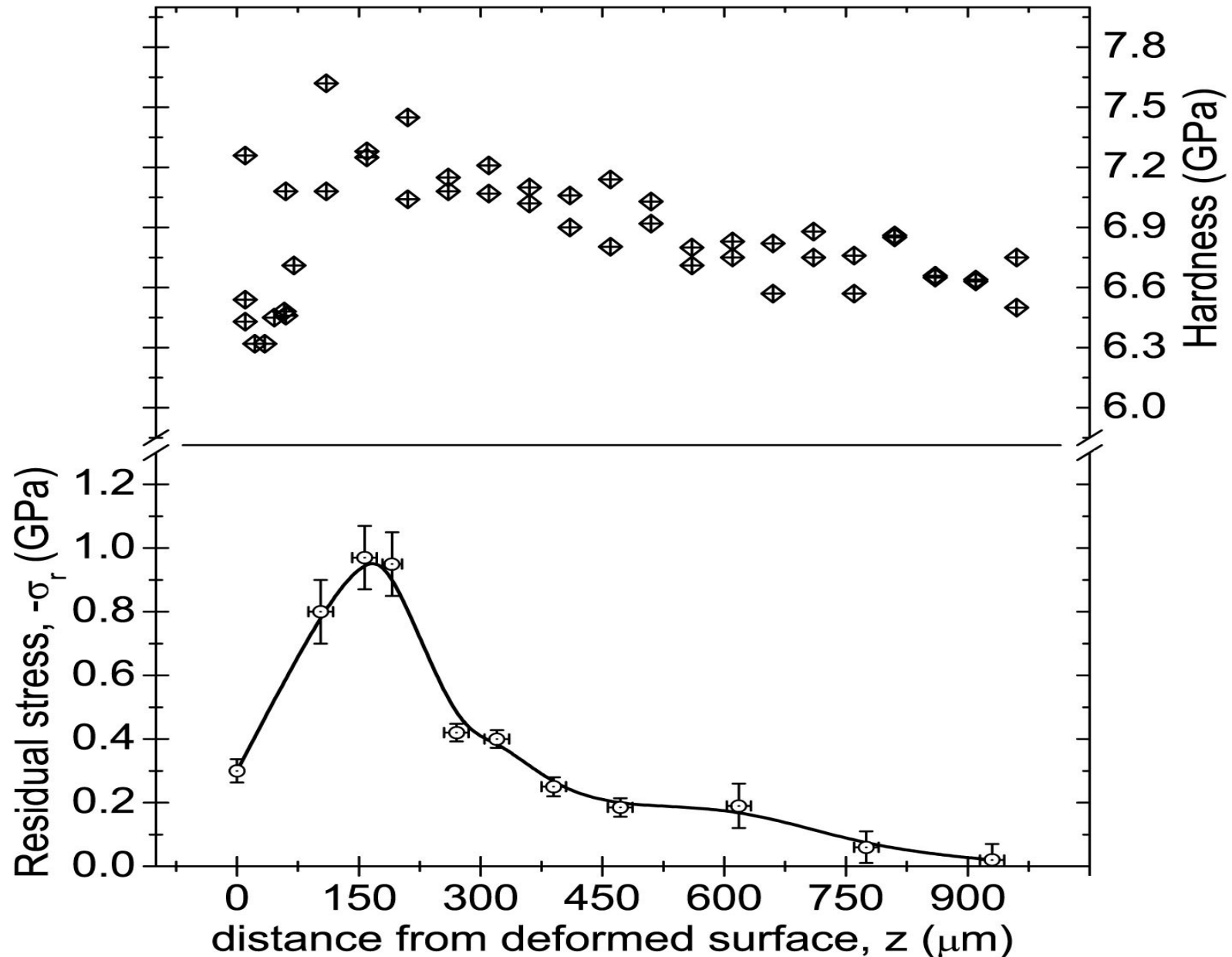
DSC shows that the crystallization enthalpy, ΔH_2 , decreases as the processing time increases

Residual stress measurement through focused ion-beam (FIB)

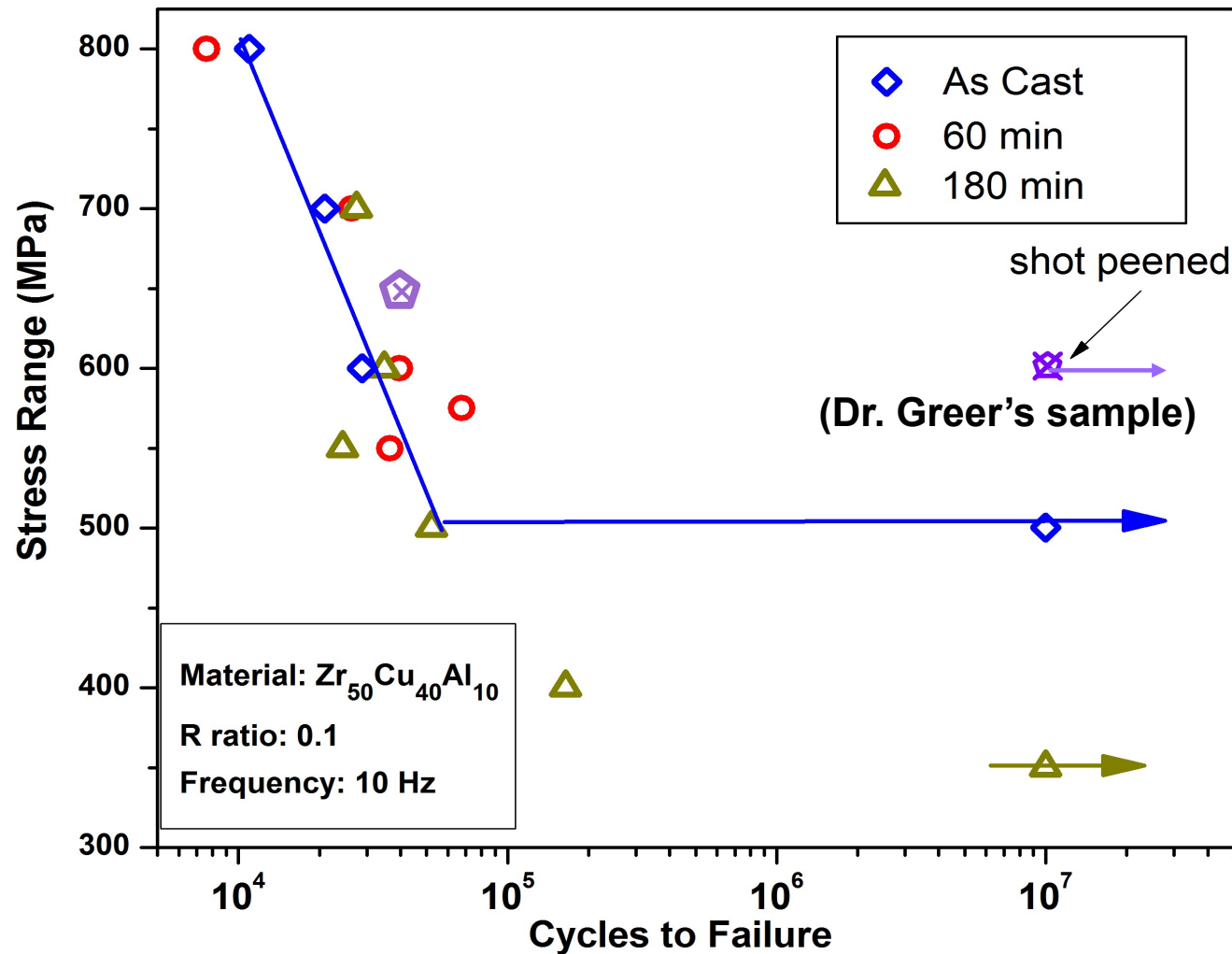


B. Winiarski, J.W. Tian, R.M. Langford, P.K. Liaw, and P.J. Withers, "Residual stress measurements of amorphous materials using a focused ion beam", (in preparation)

Microhardness and residual stress profiles

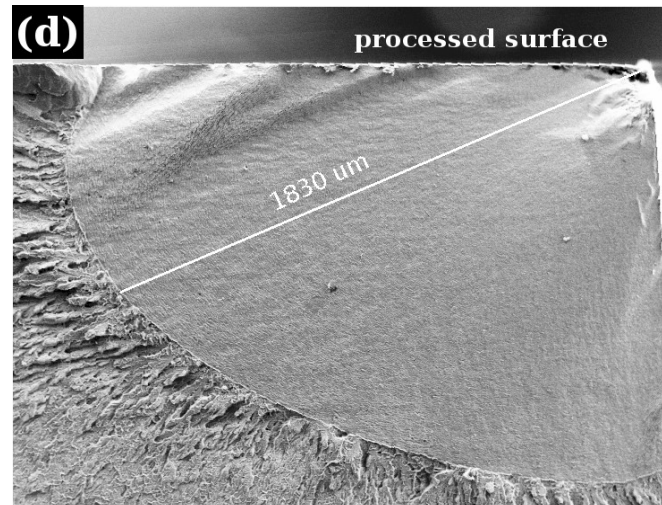
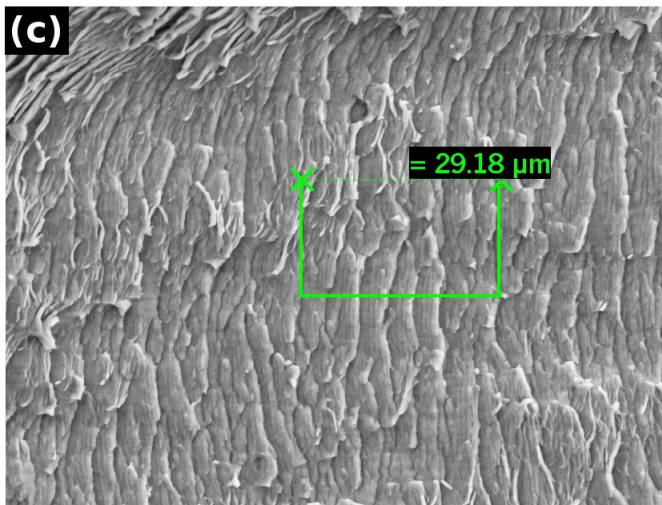
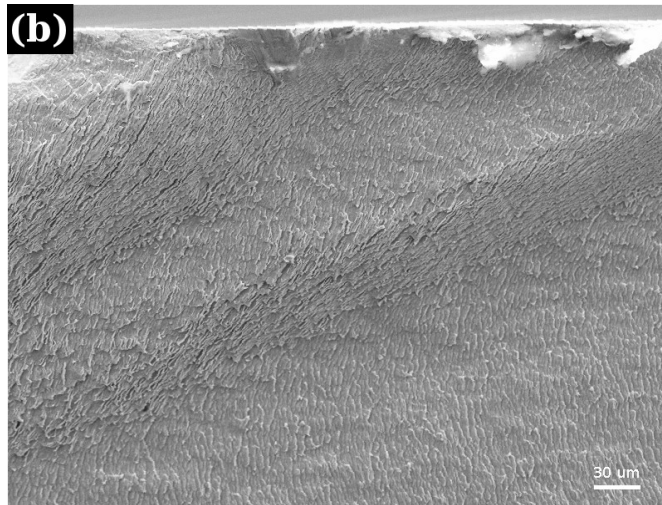
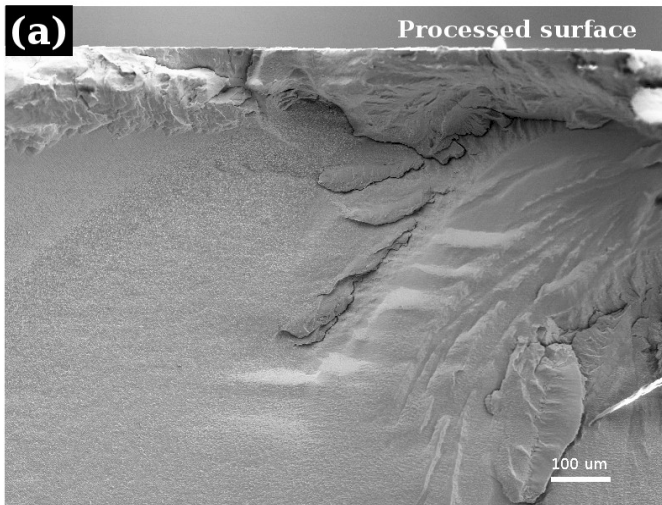


Decreased Fatigue Strength



* The as-cast results were from Dr. G.Y. Wang
G.Y. Wang, P.K.Liaw, W.H. Peter, et al., Fatigue behavior of bulk metallic glasses, Intermetallics, 2004(12), 885-892

Fractography of Fatigue Samples

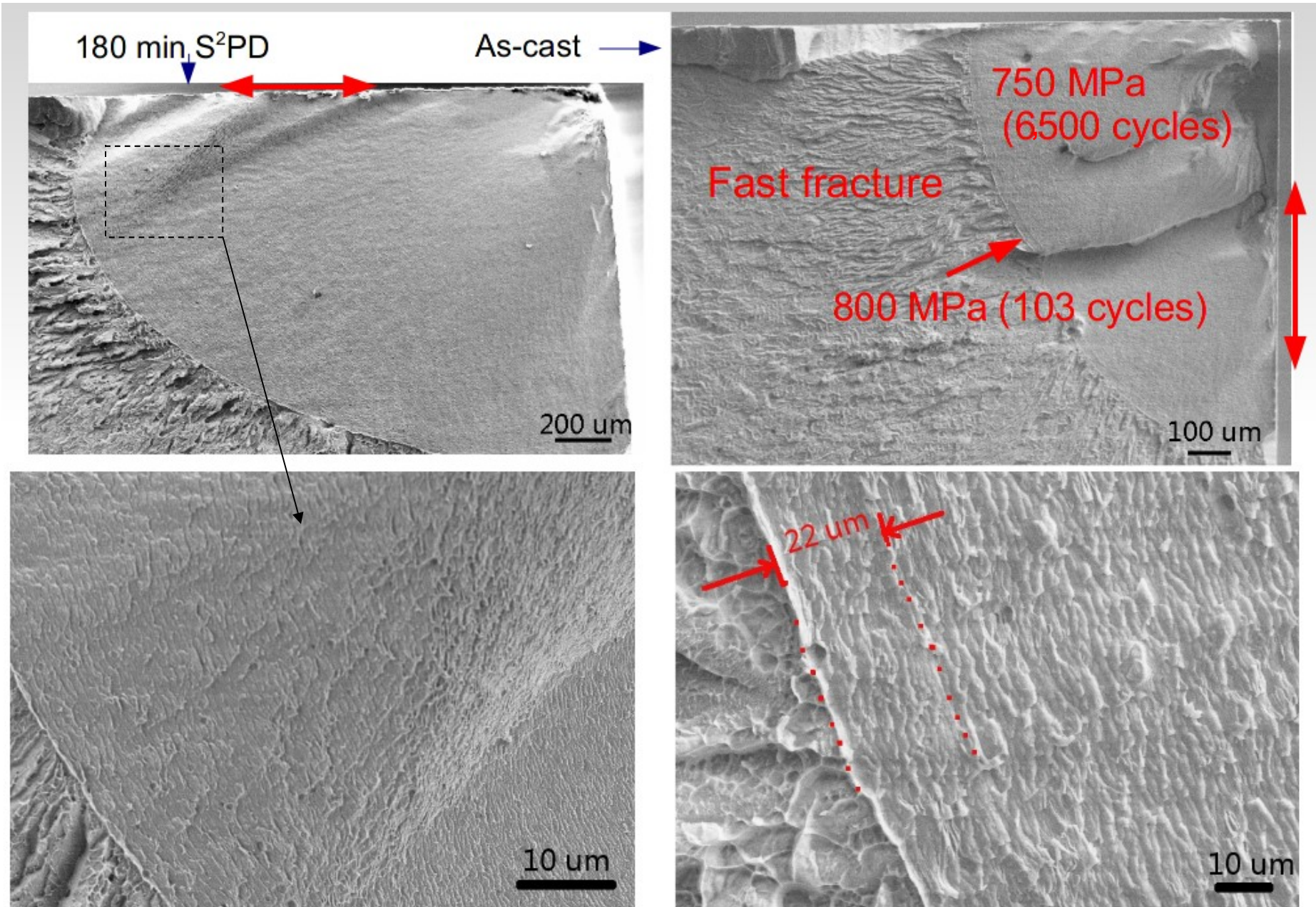


Sample: $\text{Zr}_{50}\text{Cu}_{40}\text{Al}_{10}$
Processing time: 60 min
Load: 800 MPa
Fatigue Life: 7633 cycle

Striation width: $\sim 4.17 \mu\text{m}$
of Striations: ~ 439

% of propagation
in total life:
 $439/7633 = 5.75\%$

One cycle, One striation?



Conclusion: Propagation life takes about 50% of the total life

Conclusions:

- Changes after the S²PD process are:
 - the formation of a surface nanocrystalline layer;
 - the surface work hardening;
 - the presence of residual compressive in-plane stresses at the surface layer;
 - the increased surface roughness;
 - the surface contamination due to the material transfer between balls and the plate.
- Fatigue strength of the S²PD-treated samples were highly improved due to the nano-layer, residual compressive and work hardening under certain processing conditions; However, excessive treatment may deteriorate the fatigue properties.

Conclusions (cont'd)

- For the BMG material, the process could increase the free volume, and both work hardening and work softening were identified;
- Nano-crystallites were identified after the treatment, and as the distance from the processed surface increases, the amount of nano-crystallites decrease;
- T_g , T_x remain unchanged after the deformation process, and the fatigue property does not benefit from the treatment due to the possible surface damage.

Selected Publications

- J.W. Tian, J.C. Villegas, W. Yuan, D. Fielden, L. Shaw, P.K. Liaw, and D.L. Klarstrom, "A study of the effect of nanostructured surface layers on the fatigue behaviors of a C-2000 superalloy", Materials Science and Engineering: A, 468-470(11), 2007, pp.164-170
- J.W. Tian, K. Dai, J.C. Villegas, L.L. Shaw, P.K. Liaw, D.L. Klarstrome, and A.L. Ortiz, "Tensile properties of a nickel-base alloy subjected to surface severe plastic deformation", Materials Science and Engineering: A, 493(1-2), 2008, pp.176-183
- J. W. Tian, L.L. Shaw, P. K. Liaw, and K. Dai, "On the ductility of a surface severely plastically deformed nickel alloy", Materials Science and Engineering: A, 498(1-2), 2008, pp. 216-224
- J. W. Tian, L.L. Shaw, Y.D. Wang, Y. Yokoyama, and P.K. Liaw , "A Study on the Surface-Severe-Plastic Deformation Behavior of a Zr-based Bulk-Metallic Glass (BMG)", (revised version under review)
- A.L. Ortiz, J.W. Tian, J.C. Villegas, L.L. Shaw, and P.K. Liaw, "Interrogation of the microstructure and residual stress of a nickel-base alloy subjected to surface severe plastic deformation" Acta Materialia, 56(3), 2008, pp. 413-426
- B. Winiarski, J.W. Tian, R.M. Langford, P.K. Liaw, and P.J. Withers, "Residualstress measurements of amorphous materials using a focused ion beam", (in preparation)

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